



# SMARTsemi

## Memory IC Datasheet

*DDR4-3200 8Gb x8*

July 1, 2022  
Rev 1.0



**Part Number Decoder**

| K | T | D | M | 8 | G | 4 | B | 8 | 3  | 2  | B  | G  | x  | B  | C  | T  |
|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|----|
| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 |

|       |                                                      |
|-------|------------------------------------------------------|
| 1-2   | <b>IC Supplier</b><br>KT: SMARTsemi                  |
| 3-4   | <b>Product Family</b><br>DM: DRAM                    |
| 5-6   | <b>Density</b><br>8G: 8Gb                            |
| 7     | <b>Technology</b><br>4: DDR4                         |
| 8     | <b>Voltage</b><br>B: 1.2V                            |
| 9     | <b>Width</b><br>8: x8                                |
| 10-11 | <b>Speed</b><br>32: DDR4-3200                        |
| 12-13 | <b>Package</b><br>BG: Mono BGA                       |
| 14    | <b>Temperature</b><br>C: Commercial<br>I: Industrial |
| 15-16 | <b>Internal Code</b><br>BC: For Internal Use         |
| 17    | <b>Packaging</b><br>T: Tray                          |

**Revision History**

| Date         | Description     |
|--------------|-----------------|
| July 1, 2022 | Initial release |

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## DDR4 SDRAM

**512 Mb x 8**  
**DDR4 SDRAM**

### Features

- Power supply (JEDEC standard 1.2V)
  - VDD = 1.2V ± 5%
  - VPP = 2.375V to 2.75V
- 16 internal banks (x8): 4 groups of 4 banks each
- Interface: Pseudo Open Drain (POD)
- Burst Length (BL): 8 and 4 with Burst Chop (BC)
- CAS Latency (CL):
  - 10, (11), 12, (13), 14, (15), 16, (17), 18, 19, 20, 22, 24
- CAS Write Latency (CWL): 9, 10, 11, 12, 14, 16, 18, 20
- On-Die Termination (ODT): nom. values of RZQ/7, RZQ/5 (RZQ = 240Ω)
- Precharge: auto precharge option for each burst access
- Refresh: auto-refresh, self-refresh
- Refresh cycles
  - Average refresh period
  - 7.8μs at T<sub>C</sub> ≤ +85°C
  - 3.9μs at +85°C < T<sub>C</sub> ≤ +95°C
- Double-data-rate architecture: two data transfers per clock cycle
- The high-speed data transfer is realized by the 8 bits prefetch pipelined architecture
- Bi-directional differential data strobe (DQS<sub>t</sub> and DQS<sub>c</sub>) is transmitted/received with data for capturing data at the receiver
- Termination Data Strobe is supported (x8 only) (TDQS<sub>t</sub> and TDQS<sub>c</sub>)
- DQS is edge-aligned with data for READs; center aligned with data for WRITEs
- Differential clock inputs (CK<sub>t</sub> and CK<sub>c</sub>)
- PPR and sPPR is supported
- DLL aligns DQ and DQS transitions with CK transitions
- Commands entered on each positive CK edge; data and data mask referenced to both edges of DQS
- Data Mask (DM) for write data
- Write Cyclic Redundancy Code (CRC) for DQ error detect and inform it to controller during high-speed operation
- Data Bus Inversion (DBI)
- Programmable preamble is supported both of 1tCK and 2tCK mode
- Command Address (CA) Parity for command/address signal error detect and inform it to controller
- VREFDQ training
  - VREFDQ generate inside DRAM and further train per DRAM
- Per DRAM Addressability (PDA)
  - Each DRAM can be set a different mode register value individually and has individual adjustment.
- Fine granularity refresh
  - 2x, 4x mode for smaller tRFC
- Programmable Partial Array Self-Refresh (PASR)
- RESET<sub>n</sub> pin for power-up sequence and reset function
- Operating case temperature range:
  - Commercial: T<sub>C</sub> = 0°C to +95°C
  - Industrial: T<sub>C</sub> = -40°C to +95°C

### Ordering Information

| Product ID        | Max Freq. | VDD  | Data Rate (CL-tRCD-tRP) | Package     | Temperature | Packing | Comments |
|-------------------|-----------|------|-------------------------|-------------|-------------|---------|----------|
| KTDM8G4B832BGCBCT | 1333MHz   | 1.2V | DDR4-3200 (22-22-22)    | 78 ball BGA | Commercial  | Tray    | Pb-free  |
| KTDM8G4B832BGIBCT | 1333MHz   | 1.2V | DDR4-3200 (22-22-22)    | 78 ball BGA | Industrial  | Tray    | Pb-free  |

**DDR4 SDRAM Addressing**

| Configuration                                                                                                                                                                                   |                      | Device    |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|-----------|
| Bank Address                                                                                                                                                                                    | # of Bank Groups     | 4         |
|                                                                                                                                                                                                 | BG Address           | BG0~BG1   |
|                                                                                                                                                                                                 | Bank Address in a BG | BA0 – BA1 |
| Row Address                                                                                                                                                                                     |                      | A0 – A15  |
| Column Address                                                                                                                                                                                  |                      | A0 – A9   |
| Page size                                                                                                                                                                                       |                      | 1KB       |
| <b>Note:</b><br>1. Page size is per bank, calculated as follows:<br>Page size = $2^{\text{COLBITS}}$ × ORG/8, where COLBIT = the number of column address bits and ORG = the number of DQ bits. |                      |           |



## Pin Configuration – 78 balls BGA Package

< TOP View >

See the balls through the package

|   | 1       | 2            | 3      | 4 | 5 | 6 | 7                         | 8             | 9       |
|---|---------|--------------|--------|---|---|---|---------------------------|---------------|---------|
| A | VDD     | VSSQ         | TDQS_c |   |   |   | DM_n,<br>DBI_n,<br>TDQS_1 | VSSQ          | VSS     |
| B | VPP     | VDDQ         | DQS_c  |   |   |   | DQ1                       | VDDQ          | ZQ      |
| C | VDDQ    | DQ0          | DQS_t  |   |   |   | VDD                       | VSS           | VDDQ    |
| D | VSSQ    | DQ4          | DQ2    |   |   |   | DQ3                       | DQ5           | VSSQ    |
| E | VSS     | VDDQ         | DQ6    |   |   |   | DQ7                       | VDDQ          | VSS     |
| F | VDD     | NC           | ODT    |   |   |   | CK_t                      | CK_c          | VDD     |
| G | VSS     | NC           | CKE    |   |   |   | CS_n                      | NC            | TEN     |
| H | VDD     | WE_n/<br>A14 | ACT_n  |   |   |   | CAS_n/<br>A15             | RAS_n/<br>A16 | VSS     |
| J | VREFCA  | BG0          | A10/AP |   |   |   | A12/<br>BC_n              | BG1           | VDD     |
| K | VSS     | BA0          | A4     |   |   |   | A3                        | BA1           | VSS     |
| L | RESET_n | A6           | A0     |   |   |   | A1                        | A5            | ALERT_n |
| M | VDD     | A8           | A2     |   |   |   | A9                        | A7            | VPP     |
| N | VSS     | A11          | PAR    |   |   |   | NC                        | A13           | VDD     |

## Input / Output Functional Description

| Symbol                               | Type          | Function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|--------------------------------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CK_t, CK_c                           | Input         | <b>Clock:</b> CK_t and CK_c are differential clock inputs. All address and control input signals are sampled on the crossing of the positive edge of CK_t and negative edge of CK_c.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| CKE                                  | Input         | <b>Clock Enable:</b> CKE HIGH activates, and CKE Low deactivates, internal clock signals and device input buffers and output drivers. Taking CKE Low provides Precharge Power-Down and Self-Refresh operation (all banks idle), or Active Power-Down (row Active in any bank). CKE is synchronous for Self-Refresh exit. After VREFCA and Internal DQ Vref have become stable during the power on and initialization sequence, they must be maintained during all operations (including Self-Refresh). CKE must be maintained high throughout read and write accesses. Input buffers, excluding CK_t, CK_c, ODT and CKE are disabled during power-down. Input buffers, excluding CKE, are disabled during Self-Refresh. |
| CS_n                                 | Input         | <b>Chip Select:</b> All commands are masked when CS_n is registered high. CS_n provides for external rank selection on systems with multiple memory ranks. CS_n is considered part of the command code.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| ODT                                  | Input         | <b>On Die Termination:</b> ODT (registered HIGH) enables termination resistance internal to the DDR4 SDRAM. When enabled, ODT is only applied to each DQ, DQS_t, DQS_c and DM_n/DBI_n/TDQS_t, NU/TDQS_c (When TDQS is enabled via Mode Register A11=1 in MR1) signal for x8 configurations. The ODT pin will be ignored if MR1 is programmed to disable RTT_NOM.                                                                                                                                                                                                                                                                                                                                                        |
| ACT_n                                | Input         | <b>Activation Command Input:</b> ACT_n defines the Activation command being entered along with CS_n. The input into RAS_n/A16, CAS_n/A15 and WE_n/A14 will be considered as Row Address A16, A15 and A14                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| RAS_n/A16,<br>CAS_n/A15,<br>WE_n/A14 | Input         | <b>Command Inputs:</b> RAS_n/A16, CAS_n/A15 and WE_n/A14 (along with CS_n) define the command being entered. Those pins have multi function. For example, for activation with ACT_n Low, those are Addressing like A16, A15 and A14 but for non-activation command with ACT_n High, those are Command pins for Read, Write and other command defined in command truth table                                                                                                                                                                                                                                                                                                                                             |
| DM_n, DBI_n,<br>TDQS_n               | Input/ Output | <b>Input Data Mask and Data Bus Inversion:</b> DM_n is an input mask signal for write data. Input data is masked when DM_n is sampled LOW coincident with that input data during a Write access. DM_n is sampled on both edges of DQS. DM is muxed with DBI function by Mode Register A10, A11, A12 setting in MR5. For x8 device, the function of DM or TDQS is enabled by Mode Register A11 setting in MR1. DBI_n is an input/output identifying whether to store/output the true or inverted data. If DBI_n is LOW, the data will be stored/output after inversion inside the DDR4 SDRAM and not inverted if DBI_n is HIGH. TDQS is only supported in X8.                                                            |
| BG0 - BG1                            | Input         | <b>Bank Group Inputs:</b> BG0 define to which bank group an Active, Read, Write or Precharge command is being applied. BG0 also determines which mode register is to be accessed during a MRS cycle. x8 have BG0 and BG1.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| BA0 - BA1                            | Input         | <b>Bank Address Inputs:</b> BA0 - BA1 define to which bank an Active, Read, Write or Precharge command is being applied. Bank address also determines which mode register is to be accessed during a MRS cycle.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| A0 - A16                             | Input         | <b>Address Inputs:</b> Provide the row address for ACTIVATE Commands and the column address for Read/Write commands to select one location out of the memory array in the respective bank. (A10/AP, A12/BC_n, RAS_n/A16, CAS_n/A15 and WE_n/A14 have additional functions, see other rows. The address inputs also provide the op-code during Mode Register Set commands                                                                                                                                                                                                                                                                                                                                                |
| A10 / AP                             | Input         | <b>Auto-precharge:</b> A10 is sampled during Read/Write commands to determine whether Autoprecharge should be performed to the accessed bank after the Read/Write operation. (HIGH: Autoprecharge; LOW: no Autoprecharge). A10 is sampled during a Precharge command to determine whether the Precharge applies to one bank (A10 LOW) or all banks (A10 HIGH). If only one bank is to be precharged, the bank is selected by bank addresses.                                                                                                                                                                                                                                                                            |

| Symbol                                                                                                                                                 | Type           | Function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|--------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A12 / BC_n                                                                                                                                             | Input          | <b>Burst Chop:</b> A12 / BC_n is sampled during Read and Write commands to determine if burst chop (on-the-fly) will be performed. (HIGH, no burst chop; LOW: burst chopped). See command truth table for details.                                                                                                                                                                                                                                                                                                                                                                 |
| RESET_n                                                                                                                                                | Input          | <b>Active Low Asynchronous Reset:</b> Reset is active when RESET_n is LOW, and inactive when RESET_n is HIGH. RESET_n must be HIGH during normal operation. RESET_n is a CMOS rail to rail signal with DC high and low at 80% and 20% of VDD.                                                                                                                                                                                                                                                                                                                                      |
| DQ                                                                                                                                                     | Input / Output | <b>Data Input/ Output:</b> Bi-directional data bus. If CRC is enabled via Mode register then CRC code is added at the end of Data Burst. Any DQ from DQ0~DQ3 may indicate the internal Vref level during test via Mode Register Setting MR4 A4=High. During this mode, RTT value should be set to Hi-Z. Refer to vendor specific datasheets to determine which DQ is used.                                                                                                                                                                                                         |
| DQS_t, DQS_c,                                                                                                                                          | Input/ Output  | <b>Data Strobe:</b> output with read data, input with write data. Edge-aligned with read data, centered in write data. The data strobe DQS_t is paired with differential signals DQS_c, respectively, to provide differential pair signaling to the system during reads and writes. DDR4 SDRAM supports differential data strobe only and does not support single-ended.                                                                                                                                                                                                           |
| TDQS_t, TDQS_c                                                                                                                                         | Output         | Termination Data Strobe: TDQS_t/TDQS_c is applicable for x8 DRAMs only. When enabled via Mode Register A11 = 1 in MR1, the DRAM will enable the same termination resistance function on TDQS_t/TDQS_c that is applied to DQS_t/DQS_c. When disabled via mode register A11 = 0 in MR1, DM/DBI/TDQS will provide the data mask function or Data Bus Inversion depending on MR5; A11,12,10 and TDQS_c is not used.                                                                                                                                                                    |
| PAR                                                                                                                                                    | Input          | <b>Command and Address Parity Input:</b> DDR4 Supports Even Parity check in DRAM with MR setting. Once it's enabled via Register in MR5, then DRAM calculates Parity with ACT_n, RAS_n/A16, CAS_n/A15, WE_n/A14, BG0-BG1, BA0-BA1,A17-A0, and C0-C2 (3DS devices). Command and address inputs shall have parity check performed when commands are latched via the rising edge of CK and when CS_n is low.                                                                                                                                                                          |
| ALERT_n                                                                                                                                                | Input/output   | <b>Alert:</b> It has multi functions such as CRC error flag, Command and Address Parity error flag as Output signal. If there is error in CRC, then ALERT_n goes LOW for the period time interval and goes back HIGH. If there is error in Command Address Parity Check, then ALERT_n goes LOW for relatively long period until on going DRAM internal recovery transaction to complete. During Connectivity Test mode, this pin works as input. Using this signal or not is dependent on system. In case of not connected as Signal, ALERT_n Pin must be bounded to VDD on board. |
| TEN                                                                                                                                                    | Input          | <b>Connectivity Test Mode Enable:</b> optional input on x8 with densities equal to or greater than 8Gb. HIGH in this pin will enable Connectivity Test Mode operation along with other pins. It is a CMOS rail to rail signal with AC high and low at 80% and 20% of VDD. Using this signal or not is dependent on System. This pin may be DRAM internally pulled low through a weak pull-down resistor to VSS.                                                                                                                                                                    |
| NC                                                                                                                                                     | -              | <b>No Connect:</b> No internal electrical connection is present.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| VDDQ                                                                                                                                                   | Supply         | <b>DQ Power Supply:</b> 1.2 V +/- 0.06V                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| VSSQ                                                                                                                                                   | Supply         | <b>DQ Ground</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| VDD                                                                                                                                                    | Supply         | <b>Power Supply:</b> 1.2 V +/- 0.06V                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| VSS                                                                                                                                                    | Supply         | <b>Ground</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| VPP                                                                                                                                                    | Supply         | DRAM Activating Power Supply: 2.5V ( 2.375V min , 2.75V max)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| VREFCA                                                                                                                                                 | Supply         | <b>Reference voltage for CA</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| ZQ                                                                                                                                                     | Supply         | <b>Reference pin for ZQ calibration.</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| <b>Note:</b> Input only pins (BG0-BG1, BA0-BA1, A0-A17, ACT_n, RAS_n/A16, CAS_n/A15, WE_n/A14, CS_n, CKE, ODT, and RESET_n) do not supply termination. |                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |

### tREFI and tRFC parameters

The default Refresh rate mode is fixed 1x mode where Refresh commands should be issued with the normal rate, i.e.,  $tREFI1 = tREFI(base)$  (for  $T_{case} \leq 85^{\circ}C$ ), and the duration of each refresh command is the normal refresh cycle time (tRFC1). In 2x mode (either fixed 2x or on-the-fly 2x mode), Refresh commands should be issued to the DRAM at the double frequency ( $tREFI2 = tREFI(base)/2$ ) of the normal Refresh rate. In 4x mode, Refresh command rate should be quadrupled ( $tREFI4 = tREFI(base)/4$ ). Per each mode and command type, tRFC parameter has different values as defined in table of tREFI and tRFC parameters.

The refresh command that should be issued at the normal refresh rate and has the normal refresh cycle duration may be referred to as a REF1x command. The refresh command that should be issued at the double frequency ( $tREFI2 = tREFI(base)/2$ ) may be referred to as a REF2x command. Finally, the refresh command that should be issued at the quadruple rate ( $tREFI4 = tREFI(base)/4$ ) may be referred to as a REF4x command.

In the Fixed 1x Refresh rate mode, only REF1x commands are permitted. In the Fixed 2x Refresh rate mode, only REF2x commands are permitted. In the Fixed 4x Refresh rate mode, only REF4x commands are permitted. When the on-the-fly 1x/2x Refresh rate mode is enabled, both REF1x and REF2x commands are permitted. When the on-the-fly 1x/4x Refresh rate mode is enabled, both REF1x and REF4x commands are permitted.

### tREFI and tRFC parameters

| Refresh Mode | Parameter   |                                           | 8 Gb          | Unit |
|--------------|-------------|-------------------------------------------|---------------|------|
|              | tREFI(base) |                                           | 7.8           | us   |
| 1X mode      | tREFI1      | $T_{CASE} \leq 85^{\circ}C$               | tREFI(base)   | us   |
|              |             | $85^{\circ}C < T_{CASE} \leq 95^{\circ}C$ | tREFI(base)/2 | us   |
|              | tRFC1(min)  |                                           | 350           | ns   |
| 2X mode      | tREFI2      | $T_{CASE} \leq 85^{\circ}C$               | tREFI(base)/2 | us   |
|              |             | $85^{\circ}C < T_{CASE} \leq 95^{\circ}C$ | tREFI(base)/4 | us   |
|              | tRFC2(min)  |                                           | 260           | ns   |
| 4X mode      | tREFI4      | $T_{CASE} \leq 85^{\circ}C$               | tREFI(base)/4 | us   |
|              |             | $85^{\circ}C < T_{CASE} \leq 95^{\circ}C$ | tREFI(base)/8 | us   |
|              | tRFC4(min)  |                                           | 160           | ns   |

## Absolute Maximum Ratings

### Absolute Maximum DC Ratings

| Symbol                             | Parameter                                        | Rating      | Unit | Note  |
|------------------------------------|--------------------------------------------------|-------------|------|-------|
| VDD                                | Voltage on VDD pin relative to VSS               | -0.3 ~ 1.5  | V    | 1,3   |
| VDDQ                               | Voltage on VDDQ pin relative to VSS              | -0.3 ~ 1.5  | V    | 1,3   |
| VPP                                | Voltage on VPP pin relative to VSS               | -0.3 ~ 3.0  | V    | 4     |
| V <sub>IN</sub> , V <sub>OUT</sub> | Voltage on any pin except VREFCA relative to VSS | -0.3 ~ 1.5  | V    | 1,3,5 |
| T <sub>STG</sub>                   | Storage Temperature                              | -55 to +100 | °C   | 1,2   |

**Note:**

- Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- Storage Temperature is the case surface temperature on the center/top side of the DRAM. For the measurement conditions, please refer to JESD51-2 standard.
- VDD and VDDQ must be within 300 mV of each other at all times; and VREFCA must be not greater than 0.6 x VDDQ, When VDD and VDDQ are less than 500 mV; VREFCA may be equal to or less than 300 mV
- VPP must be equal or greater than VDD/VDDQ at all times.
- Overshoot area above 1.5 V is specified.

## AC & DC Operating Conditions

### Recommended DC Operating Conditions

| Symbol | Parameter                 | Rating |      |      | Unit | Note  |
|--------|---------------------------|--------|------|------|------|-------|
|        |                           | Min.   | Typ. | Max. |      |       |
| VDD    | Supply Voltage            | 1.14   | 1.2  | 1.26 | V    | 1,2,3 |
| VDDQ   | Supply Voltage for Output | 1.14   | 1.2  | 1.26 | V    | 1,2,3 |
| VPP    |                           | 2.375  | 2.5  | 2.75 | V    | 3     |

**Note:**

- Under all conditions VDDQ must be less than or equal to VDD.
- VDDQ tracks with VDD. AC parameters are measured with VDD and VDDQ tied together.
- DC bandwidth is limited to 20MHz.

### Recommended Operating Temperature Ranges

| Parameter/Condition    | Symbol            | Min   | Max-Normal | Max-Extended |
|------------------------|-------------------|-------|------------|--------------|
| Commercial Temperature | T <sub>OPER</sub> | 0°C   | 85°C       | 95°C         |
| Industrial Temperature | T <sub>OPER</sub> | -40°C | 85°C       | 95°C         |

**Note:**

- The operating temperature is the case surface temperature on the center-top side of the DDR4 device. For measurements conditions, refer to JESD51-2.
- Max-Normal is the maximum limit when device is operating in the Normal Temperature Mode.
- Max-Extended is the maximum limit when device is operating in the Extended Temperature Mode.

## AC & DC Logic input levels for single-ended signals

### Single-ended AC & DC input levels for Command and Address

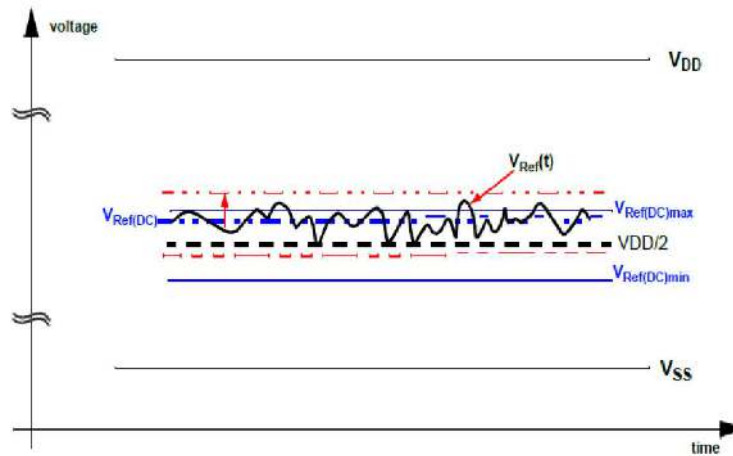
| Symbol            | Parameter                             | DDR4-3200           |                     | Unit | Note |
|-------------------|---------------------------------------|---------------------|---------------------|------|------|
|                   |                                       | Min.                | Max.                |      |      |
| $V_{IH,CA}(DC65)$ | DC input logic high                   | $V_{REFCA} + 0.065$ | $V_{DD}$            | V    |      |
| $V_{IL,CA}(DC65)$ | DC input logic low                    | $V_{SS}$            | $V_{REFCA} - 0.065$ | V    |      |
| $V_{IH,CA}(AC90)$ | AC input logic high                   | $V_{REF} + 0.09$    | Note 2              | V    | 1    |
| $V_{IL,CA}(AC90)$ | AC input logic low                    | Note 2              | $V_{REF} - 0.09$    | V    | 1    |
| $V_{REFCA}(DC)$   | Reference Voltage for ADD, CMD inputs | $0.49 \cdot V_{DD}$ | $0.51 \cdot V_{DD}$ | V    | 2,3  |

**Note:**

1. See "Overshoot and Undershoot Specifications".
2. The AC peak noise on  $V_{REFCA}$  may not allow  $V_{REFCA}$  to deviate from  $V_{REFCA}(DC)$  by more than  $\pm 1\% V_{DD}$  (for reference : approx.  $\pm 12mV$ ).
3. For reference : approx.  $V_{DD}/2 \pm 12mV$ .

## AC and DC Input Measurement Levels: $V_{REF}$ Tolerances

The DC-tolerance limits and ac-noise limits for the reference voltages  $V_{REFCA}$  is illustrated in Illustration of  $V_{REF(DC)}$  tolerance and  $V_{REF}$  AC-noise limits figure. It shows a valid reference voltage  $V_{REF}(t)$  as a function of time. ( $V_{REF}$  stands for  $V_{REFCA}$ ).  $V_{REF(DC)}$  is the linear average of  $V_{REF}(t)$  over a very long period of time (e.g., 1 sec). This average has to meet the min/max requirement in Single-ended AC & DC input levels for Command and Address table. Furthermore  $V_{REF}(t)$  may temporarily deviate from  $V_{REF(DC)}$  by no more than  $\pm 1\% V_{DD}$ .



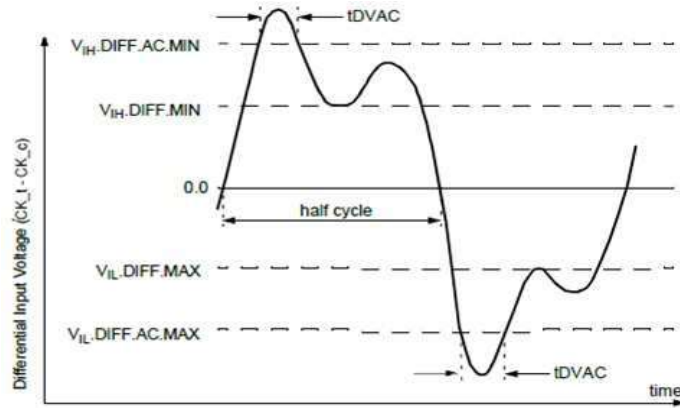
**Illustration of  $V_{REF(DC)}$  tolerance and  $V_{REF}$  AC-noise limits**

The voltage levels for setup and hold time measurements  $V_{IH(AC)}$ ,  $V_{IH(DC)}$ ,  $V_{IL(AC)}$  and  $V_{IL(DC)}$  are dependent on  $V_{REF}$ . " $V_{REF}$ " shall be understood as  $V_{REF(DC)}$ , as defined in Illustration of  $V_{REF(DC)}$  tolerance and  $V_{REF}$  AC-noise limits figure. This clarifies, that DC-variations of  $V_{REF}$  affect the absolute voltage a signal has to reach to achieve a valid high or low level and therefore the time to which setup and hold is measured. System timing and voltage budgets need to account for  $V_{REF(DC)}$  deviations from the optimum position within the data-eye of the input signals.

This also clarifies that the DRAM setup/hold specification and derating values need to include time and voltage associated with  $V_{REF}$  AC-noise. Timing and voltage effects due to AC-noise on  $V_{REF}$  up to the specified limit ( $\pm 1\%$  of  $V_{DD}$ ) are included in DRAM timings and their associated deratings.

## AC and DC Logic Input Levels for Differential Signals

### Differential signal definition



### Definition of differential ac-swing and "time above ac-level" tDVAC

**Note:**

1. Differential signal rising edge from  $V_{IL,DIFF.MAX}$  to  $V_{IH,DIFF.MIN}$  must be monotonic slope.
2. Differential signal falling edge from  $V_{IH,DIFF.MIN}$  to  $V_{IL,DIFF.MAX}$  must be monotonic slope.



## Differential swing requirements for clock (CK\_t - CK\_c)

### Differential AC and DC Input Levels

| Symbol                   | Parameter                  | DDR4-3200                                      |                                                | Unit | Note |
|--------------------------|----------------------------|------------------------------------------------|------------------------------------------------|------|------|
|                          |                            | Min.                                           | Max.                                           |      |      |
| V <sub>IHdiff</sub>      | Differential input high    | 110                                            | Note 3                                         | mV   | 1    |
| V <sub>ILdiff</sub>      | Differential input low     | Note 3                                         | -110                                           | mV   | 1    |
| V <sub>IHdiff</sub> (AC) | Differential input high ac | 2 x (V <sub>IH</sub> (AC) - V <sub>REF</sub> ) | Note 3                                         | V    | 2    |
| V <sub>ILdiff</sub> (AC) | Differential input low ac  | Note 3                                         | 2 x (V <sub>IL</sub> (AC) - V <sub>REF</sub> ) | V    | 2    |

#### Note:

- Used to define a differential signal slew-rate.
- for CK\_t - CK\_c use V<sub>IH,CA</sub>/V<sub>IL,CA</sub>(AC) of ADD/CMD and V<sub>REFCA</sub>;
- These values are not defined; however, the differential signals CK\_t - CK\_c, need to be within the respective limits (V<sub>IH,CA</sub>(DC) max, V<sub>IL,CA</sub>(DC)min) for single-ended signals as well as the limitations for overshoot and undershoot.

### Allowed time before ringback (tDVAC) for CK\_t - CK\_c

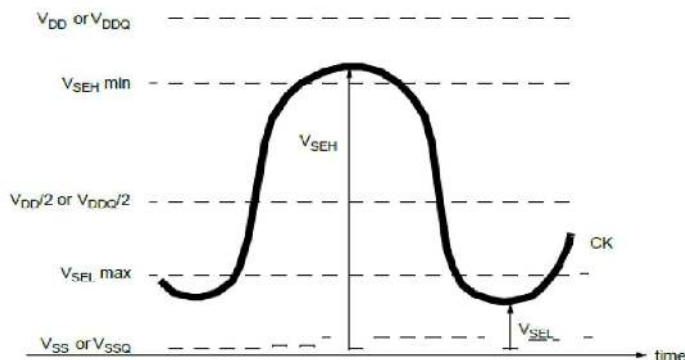
| Symbol | tDVAC [ps] @  V <sub>IH/Ldiff</sub> (AC)  = 200mV |      | tDVAC [ps] @  V <sub>IH/Ldiff</sub> (AC)  = TBDmV |      |
|--------|---------------------------------------------------|------|---------------------------------------------------|------|
|        | Min.                                              | Max. | Min.                                              | Max. |
| > 4.0  | 120                                               | -    | TBD                                               | -    |
| 4.0    | 115                                               | -    | TBD                                               | -    |
| 3.0    | 110                                               | -    | TBD                                               | -    |
| 2.0    | 105                                               | -    | TBD                                               | -    |
| 1.8    | 100                                               | -    | TBD                                               | -    |
| 1.6    | 95                                                | -    | TBD                                               | -    |
| 1.4    | 90                                                | -    | TBD                                               | -    |
| 1.2    | 85                                                | -    | TBD                                               | -    |
| 1.0    | 80                                                | -    | TBD                                               | -    |
| < 1.0  | 80                                                | -    | TBD                                               | -    |

## Single-ended requirements for differential signals

Each individual component of a differential signal (CK<sub>t</sub>, CK<sub>c</sub>) has also to comply with certain requirements for single-ended signals.

CK<sub>t</sub> and CK<sub>c</sub> have to approximately reach VSEHmin / VSELmax (approximately equal to the ac-levels (V<sub>IH,CA</sub>(AC) / V<sub>IL,CA</sub>(AC) ) for ADD/CMD signals) in every half-cycle.

Note that the applicable ac-levels for ADD/CMD might be different per speed-bin etc. E.g., if Different value than V<sub>IH,CA</sub>(AC100)/ V<sub>IL,CA</sub>(AC100) is used for ADD/CMD signals, then these ac-levels apply also for the single-ended signals CK<sub>t</sub> and CK<sub>c</sub>.



**Single-ended requirement for differential signals**

Note that, while ADD/CMD signal requirements are with respect to VrefCA, the single-ended components of differential signals have a requirement with respect to VDD / 2; this is nominally the same. The transition of single-ended signals through the ac-levels is used to measure setup time. For single-ended components of differential signals the requirement to reach VSELmax, VSEHmin has no bearing on timing, but adds a restriction on the common mode characteristics of these signals.

### Single-ended levels for CK<sub>t</sub>, CK<sub>c</sub>

| Symbol | Parameter                                                     | DDR4-3200       |                 | Unit | Note |
|--------|---------------------------------------------------------------|-----------------|-----------------|------|------|
|        |                                                               | Min.            | Max.            |      |      |
| VSEH   | Single-ended high-level for CK <sub>t</sub> , CK <sub>c</sub> | (VDD/2) + 0.085 | Note3           | V    | 1, 2 |
| VSEL   | Single-ended low-level for CK <sub>t</sub> , CK <sub>c</sub>  | Note3           | (VDD/2) - 0.085 | V    | 1, 2 |

#### Note:

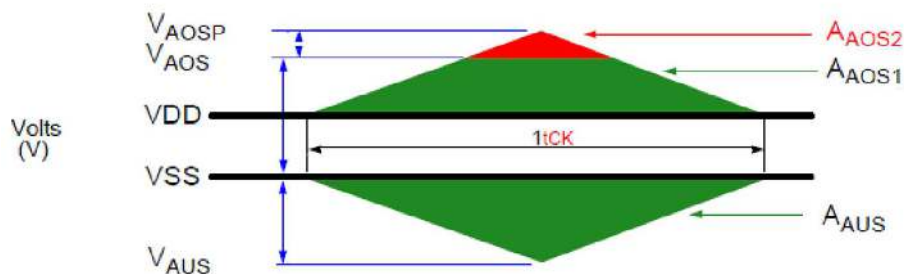
- For CK<sub>t</sub> - CK<sub>c</sub> use V<sub>IH,CA</sub>/V<sub>IL,CA</sub>(AC) of ADD/CMD;
- V<sub>IH</sub>(AC)/V<sub>IL</sub>(AC) for ADD/CMD is based on V<sub>REFCA</sub>;
- These values are not defined, however the single-ended signals CK<sub>t</sub> - CK<sub>c</sub> need to be within the respective limits (V<sub>IH,CA</sub>(DC) max, V<sub>IL,CA</sub>(DC)min) for single-ended signals as well as the limitations for overshoot and undershoot.

## Address, Command and Control Overshoot and Undershoot specifications

### AC overshoot/undershoot specification for Address, Command and Control pins

| Parameter                                                                          | Symbol     | DDR4- 3200   | Unit | Note |
|------------------------------------------------------------------------------------|------------|--------------|------|------|
| Maximum peak amplitude above $V_{AOS}$                                             | $V_{AOSP}$ | 0.06         | V    |      |
| Upper boundary of overshoot area $A_{AOS1}$                                        | $V_{AOS}$  | $VDD + 0.24$ | V    | 1    |
| Maximum peak amplitude allowed for undershoot                                      | $V_{AUS}$  | 0.30         | V    |      |
| Maximum overshoot area per 1 tCK above $V_{AOS}$                                   | $A_{AOS2}$ | 0.0055       | V    |      |
| Maximum overshoot area per 1 tCK between VDD and $V_{AOS}$                         | $A_{AOS1}$ | 0.1699       | V    |      |
| Maximum undershoot area per 1 tCK below VSS                                        | $A_{AUS}$  | 0.1762       | V    |      |
| (A0-A13,A17,BG0-BG1,BA0-BA1,ACT_n,RAS_n/A16,CAS_n/A15,WE_n/A14,CS_n,CKE,ODT,C2-C0) |            |              |      |      |

**Note:** The value of  $V_{AOS}$  matches VDD absolute max as defined in Absolute Maximum DC Ratings table if VDD equals VDD max as defined in Recommended DC Operating Conditions table. If VDD is above the recommended operating conditions,  $V_{AOS}$  remains at VDD absolute max as defined in Absolute Maximum DC Ratings table.

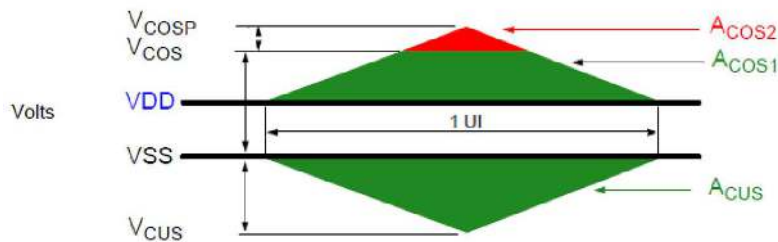


**Address, Command and Control Overshoot and Undershoot Definition**

**AC overshoot/undershoot specification for Clock**

| Parameter                                                 | Symbol     | DDR4- 3200   | Unit | Note |
|-----------------------------------------------------------|------------|--------------|------|------|
| Maximum peak amplitude above $V_{COS}$                    | $V_{COSP}$ | 0.06         | V    |      |
| Upper boundary of overshoot area $A_{DOS1}$               | $V_{COS}$  | $VDD + 0.24$ | V    | 1    |
| Maximum peak amplitude allowed for undershoot             | $V_{CUS}$  | 0.30         | V    |      |
| Maximum overshoot area per 1 UI above $V_{COS}$           | $A_{COS2}$ | 0.0025       | V-ns |      |
| Maximum overshoot area per 1 UI between VDD and $V_{DOS}$ | $A_{COS1}$ | 0.0750       | V-ns |      |
| Maximum undershoot area per 1 UI below VSS                | $A_{CUS}$  | 0.0762       | V-ns |      |
| (CK_t, CK_c)                                              |            |              |      |      |

**Note:** The value of  $V_{COS}$  matches VDD absolute max as defined in Absolute Maximum DC Ratings table if VDD equals VDD max as defined in Recommended DC Operating Conditions table. If VDD is above the recommended operating conditions,  $V_{COS}$  remains at VDD absolute max as defined in Absolute Maximum DC Ratings table.

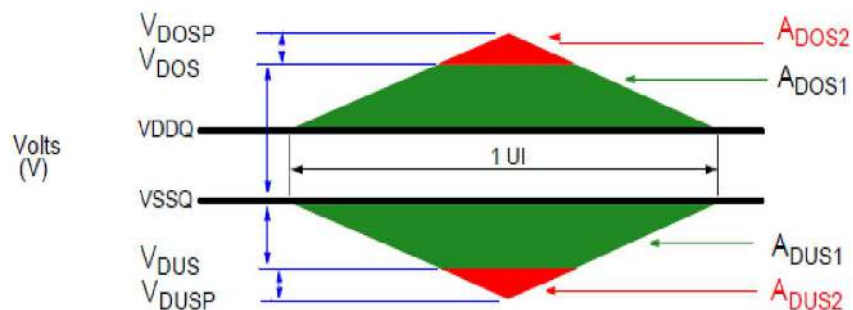

**Clock Overshoot and Undershoot Definition**

**AC overshoot/undershoot specification for Data, Strobe and Mask**

| Parameter                                                         | Symbol     | DDR4- 3200       | Unit | Note |
|-------------------------------------------------------------------|------------|------------------|------|------|
| Maximum peak amplitude above $V_{DOS}$                            | $V_{DOSP}$ | 0.16             | V    |      |
| Upper boundary of overshoot area $A_{DOS1}$                       | $V_{DOS}$  | $V_{DDQ} + 0.24$ | V    | 1    |
| Lower boundary of undershoot area $A_{DUS1}$                      | $V_{DUS}$  | 0.30             | V    | 2    |
| Maximum peak amplitude below $V_{DUS}$                            | $V_{DUSP}$ | 0.10             | V    |      |
| Maximum overshoot area per 1 UI above $V_{DOS}$                   | $A_{DOS2}$ | 0.0100           | V-ns |      |
| Maximum overshoot area per 1 UI between $V_{DDQ}$ and $V_{DOS}$   | $A_{DOS1}$ | 0.0700           | V-ns |      |
| Maximum undershoot area per 1 UI between $V_{SSQ}$ and $V_{DUS1}$ | $A_{DUS1}$ | 0.0700           | V-ns |      |
| Maximum undershoot area per 1 UI below $V_{DUS}$                  | $A_{DUS2}$ | 0.0100           | V-ns |      |
| (DQ, DQS_t, DQS_c, DM_n, DBI_n)                                   |            |                  |      |      |

**Note:**

1. The value of  $V_{DOS}$  matches ( $V_{IN}$ ,  $V_{OUT}$ ) max as defined in Absolute Maximum DC Ratings table if  $V_{DDQ}$  equals  $V_{DDQ}$  max as defined in Recommended DC Operating Conditions table. If  $V_{DDQ}$  is above the recommended operating conditions,  $V_{DOS}$  remains at ( $V_{IN}$ ,  $V_{OUT}$ ) max as defined in Absolute Maximum DC Ratings table.
2. The value of  $V_{DUS}$  matches ( $V_{IN}$ ,  $V_{OUT}$ ) min as defined in Absolute Maximum DC Ratings table.


**Data, Strobe and Mask Overshoot and Undershoot Definition**

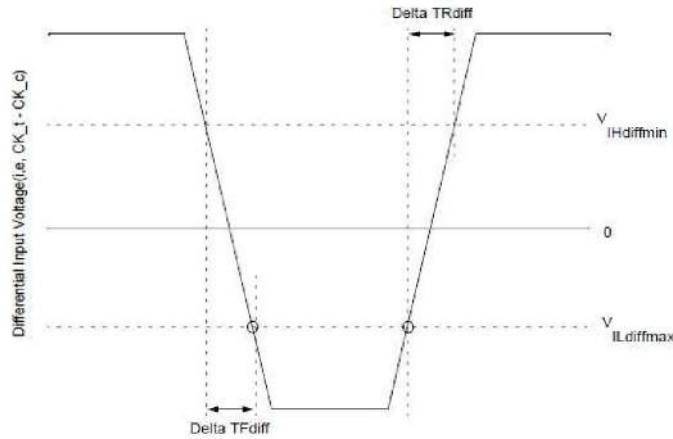
## Slew Rate Definitions for Differential Input Signals (CK)

Input slew rate for differential signals (CK<sub>t</sub>, CK<sub>c</sub>) are defined and measured as shown in Differential Input Slew Rate Definition table and Differential Input Slew Rate Definition for CK<sub>t</sub>, CK<sub>c</sub> figure.

### Differential Input Slew Rate Definition

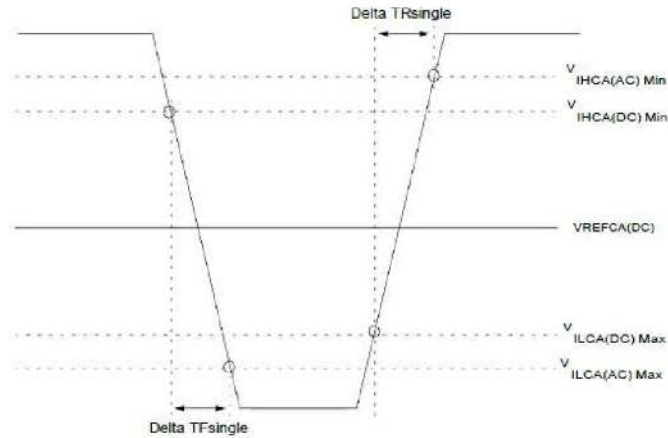
| Description                                                                       | Measured               |                        | Defined by                                           |
|-----------------------------------------------------------------------------------|------------------------|------------------------|------------------------------------------------------|
|                                                                                   | from                   | to                     |                                                      |
| Differential input slew rate for rising edge(CK <sub>t</sub> - CK <sub>c</sub> )  | V <sub>ILdiffmax</sub> | V <sub>IHdiffmin</sub> | $[V_{IHdiffmin} - V_{ILdiffmax}] / \Delta TR_{diff}$ |
| Differential input slew rate for falling edge(CK <sub>t</sub> - CK <sub>c</sub> ) | V <sub>IHdiffmin</sub> | V <sub>ILdiffmax</sub> | $[V_{IHdiffmin} - V_{ILdiffmax}] / \Delta TF_{diff}$ |

**Note:** The differential signal (i.e., CK<sub>t</sub> - CK<sub>c</sub>) must be linear between these thresholds.



**Differential Input Slew Rate Definition for CK<sub>t</sub>, CK<sub>c</sub>**

## Slew Rate Definition for Single-ended Input Signals (CMD/ADD)



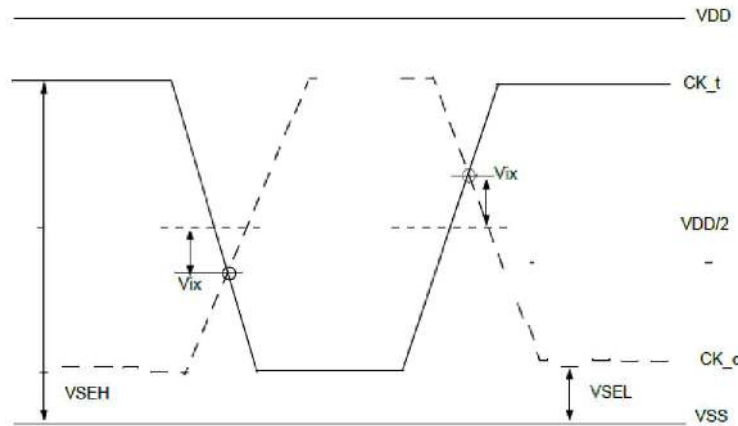
### Single-ended Input Slew Rate definition for CMD and ADD

**Note:**

1. Single-ended input slew rate for rising edge =  $\{ V_{IHCA(AC)Min} - V_{ILCA(DC)Max} \} / \text{Delta TR single}$ .
2. Single-ended input slew rate for falling edge =  $\{ V_{IHCA(DC)Min} - V_{ILCA(AC)Max} \} / \text{Delta TF single}$ .
3. Single-ended signal rising edge from  $V_{ILCA(DC)Max}$  to  $V_{IHCA(DC)Min}$  must be monotonic slope.
4. Single-ended signal falling edge from  $V_{IHCA(DC)Min}$  to  $V_{ILCA(DC)Max}$  must be monotonic slope.

## Differential Input Cross Point Voltage

To guarantee tight setup and hold times as well as output skew parameters with respect to clock, each cross point voltage of differential input signals (CK\_t, CK\_c) must meet the requirements in Cross point voltage for differential input signals (CK) table. The differential input cross point voltage VIX is measured from the actual cross point of true and complement signals to the midlevel between of VDD and VSS.



**Vix Definition (CK)**

### Cross point voltage for differential input signals (CK)

| Symbol  | Parameter                                                               | DDR4-3200                       |                                                                |                                                                |                                 |
|---------|-------------------------------------------------------------------------|---------------------------------|----------------------------------------------------------------|----------------------------------------------------------------|---------------------------------|
|         |                                                                         | min                             |                                                                | max                                                            |                                 |
| -       | Area of VSEH, VSEL                                                      | $VSEL < VDD/2 - 145 \text{ mV}$ | $VDD/2 - 145 \text{ mV} \leq VSEL \leq VDD/2 - 100 \text{ mV}$ | $VDD/2 + 100 \text{ mV} \leq VSEH \leq VDD/2 + 145 \text{ mV}$ | $VDD/2 + 145 \text{ mV} < VSEH$ |
| VIX(CK) | Differential Input Cross Point Voltage relative to VDD/2 for CK_t, CK_c | -110 mV                         | $-(VDD/2 - VSEL) + 30 \text{ mV}$                              | $(VSEH - VDD/2) - 30 \text{ mV}$                               | 110 mV                          |



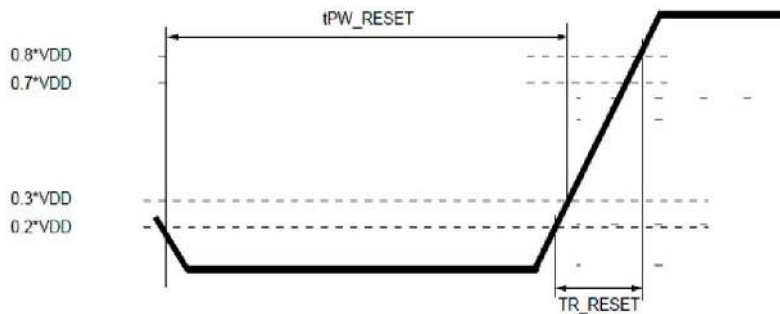
## CMOS rail to rail Input Levels

### CMOS rail to rail Input Levels for RESET\_n

| Parameter             | Symbol        | Min     | Max     | Unit | Note |
|-----------------------|---------------|---------|---------|------|------|
| AC Input High Voltage | VIH(AC)_RESET | 0.8*VDD | VDD     | V    | 6    |
| DC Input High Voltage | VIH(DC)_RESET | 0.7*VDD | VDD     | V    | 2    |
| DC Input Low Voltage  | VIL(DC)_RESET | VSS     | 0.3*VDD | V    | 1    |
| AC Input Low Voltage  | VIL(AC)_RESET | VSS     | 0.2*VDD | V    | 7    |
| Rising time           | TR_RESET      | -       | 1.0     | us   | 4    |
| RESET pulse width     | tPW_RESET     | 1.0     | -       | us   | 3,5  |

#### Note:

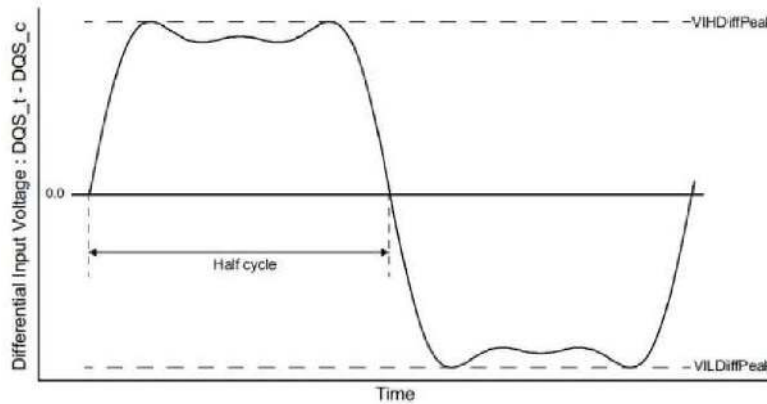
1. After RESET\_n is registered LOW, RESET\_n level shall be maintained below VIL(DC)\_RESET during tPW\_RESET, otherwise, SDRAM may not be reset.
2. Once RESET\_n is registered HIGH, RESET\_n level must be maintained above VIH(DC)\_RESET, otherwise, SDRAM operation will not be guaranteed until it is reset asserting RESET\_n signal LOW.
3. RESET is destructive to data contents.
4. No slope reversal (ringback) requirement during its level transition from Low to High.
5. This definition is applied only "Reset Procedure at Power Stable".
6. Overshoot might occur. It should be limited by the Absolute Maximum DC Ratings.
7. Undershoot might occur. It should be limited by Absolute Maximum DC Ratings.



**RESET\_n Input Slew Rate Definition**

## AC and DC Logic Input Levels for DQS Signals

### Differential signal definition



Definition of differential DQS Signal AC-swing Level

### Differential swing requirements for DQS ( $DQS_t - DQS_c$ )

#### Differential AC and DC Input Levels for DQS

| Symbol      | Parameter             | DDR4-3200 |       | Unit | Note |
|-------------|-----------------------|-----------|-------|------|------|
|             |                       | Min       | Max   |      |      |
| VIHDiffPeak | VIH.DIFF.Peak Voltage | 140       | Note2 | mV   | 1    |
| VILDiffPeak | VIL.DIFF.Peak Voltage | Note2     | -140  | mV   | 1    |

#### Note:

- Used to define a differential signal slew-rate.
- These values are not defined; however, the differential signals  $DQS_t - DQS_c$ , need to be within the respective limits Overshoot, Undershoot Specification for single-ended signals.

## Peak voltage calculation method

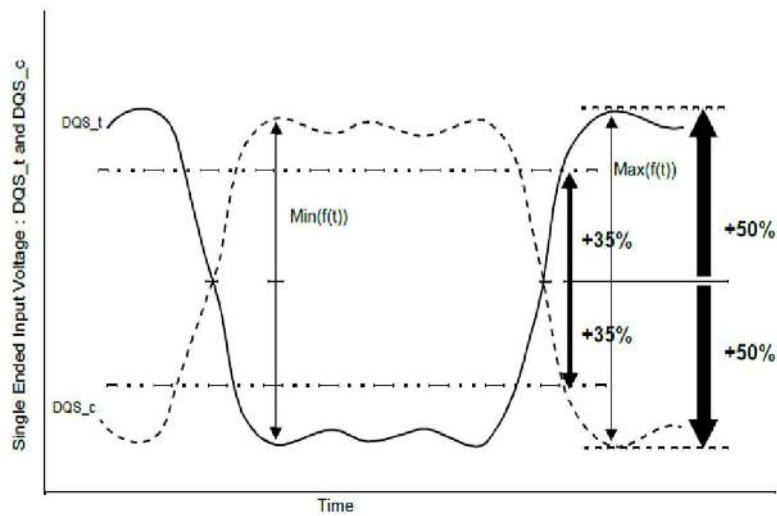
The peak voltage of Differential DQS signals are calculated in a following equation.

$$\text{VIH.DIFF.Peak Voltage} = \text{Max}(f(t))$$

$$\text{VIL.DIFF.Peak Voltage} = \text{Min}(f(t))$$

$$f(t) = \text{VDQS}_t - \text{VDQS}_c$$

The  $\text{Max}(f(t))$  or  $\text{Min}(f(t))$  used to determine the midpoint which to reference the  $\pm 35\%$  window of the exempt non-monotonic signaling shall be the smallest peak voltage observed in all UIs.



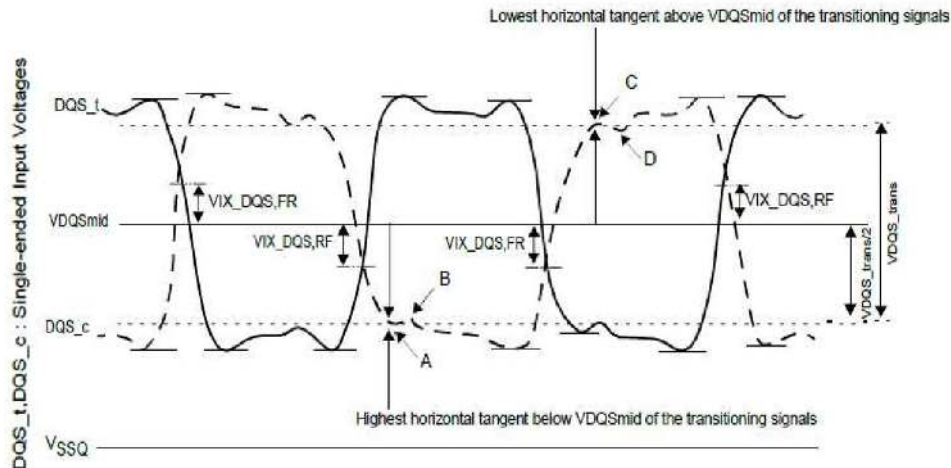
**Definition of differential DQS Peak Voltage and rage of exempt non-monotonic signaling**

## Differential Input Cross Point Voltage

To achieve tight RxMask input requirements as well as output skew parameters with respect to strobe, the cross point voltage of differential input signals (DQS\_t, DQS\_c) must meet the requirements in Cross point voltage for DQS differential input signals table. The differential input cross point voltage VIX\_DQS (VIX\_DQS\_FR and VIX\_DQS\_RF) is measured from the actual cross point of DQS\_t, DQS\_c relative to the VDQSmid of the DQS\_t and DQS\_c signals.

VDQSmid is the midpoint of the minimum levels achieved by the transitioning DQS\_t and DQS\_c signals, and noted by VDQS\_trans. VDQS\_trans is the difference between the lowest horizontal tangent above VDQSmid of the transitioning DQS signals and the highest horizontal tangent below VDQSmid of the transitioning DQS signals.

A non-monotonic transitioning signal's ledge is exempt or not used in determination of a horizontal tangent provided the said ledge occurs within +/- 35% of the midpoint of either VIH.DIFF.Peak Voltage (DQS\_t rising) or VIL.DIFF.Peak Voltage (DQS\_c rising), refer to Definition of differential DQS Peak Voltage and range of exempt non-monotonic signaling figure. A secondary horizontal tangent resulting from a ring-back transition is also exempt in determination of a horizontal tangent. That is, a falling transition's horizontal tangent is derived from its negative slope to zero slope transition (point A in Vix Definition (DQS) figure) and a ring-back's horizontal tangent derived from its positive slope to zero slope transition (point B in Vix Definition (DQS) figure) is not a valid horizontal tangent; and a rising transition's horizontal tangent is derived from its positive slope to zero slope transition (point C in Vix Definition (DQS) figure) and a ring-back's horizontal tangent derived from its negative slope to zero slope transition (point D in Vix Definition (DQS) figure) is not a valid horizontal tangent.



**Vix Definition (DQS)**

### Cross point voltage for DQS differential input signals

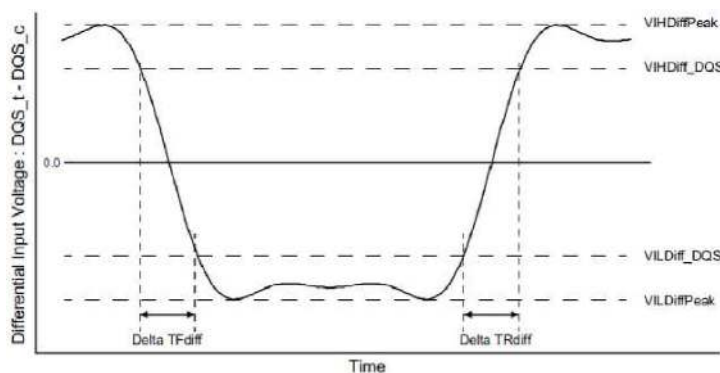
| Symbol           | Parameter                                                                              | DDR4-3200 |                     | Unit | Note    |
|------------------|----------------------------------------------------------------------------------------|-----------|---------------------|------|---------|
|                  |                                                                                        | Min       | Max                 |      |         |
| Vix_DQS_ratio    | DQS_t and DQS_c crossing relative to the midpoint of the DQS_t and DQS_c signal swings | -         | 25                  | %    | 1, 2    |
| VDQSmid_to_Vcent | VDQSmid offset relative to Vcent_DQ(midpoint)                                          | -         | Min<br>(VIHdiff,50) | mV   | 3, 4, 5 |

#### Note:

1. Vix\_DQS\_Ratio is DQS VIX crossing (Vix\_DQS\_FR or Vix\_DQS\_RF) divided by VDQS\_trans. VDQS\_trans is the difference between the lowest horizontal tangent above VDQSmid of the transitioning DQS signals and the highest horizontal tangent below VDQSmid of the transitioning DQS signals.
2. VDQSmid will be similar to the VREFDQ internal setting value obtained during Vref Training if the DQS and DQs drivers and paths are matched.
3. The maximum limit shall not exceed the smaller of VIHdiff minimum limit or 50mV.
4. VIX measurements are only applicable for transitioning DQS\_t and DQS\_c signals when toggling data, preamble and high-z states are not applicable conditions.
5. The parameter VDQSmid is defined for simulation and ATE testing purposes, it is not expected to be tested in a system.

### Differential Input Slew Rate Definition

Input slew rate for differential signals (DQS\_t, DQS\_c) are defined and measured as shown in Vix Definition (DQS) figure & Differential Input Slew Rate Definition for DQS\_t, DQS\_c figure.



#### Differential Input Slew Rate Definition for DQS\_t, DQS\_c

#### Note:

1. Differential signal rising edge from VILdiff\_DQS to VIHdiff\_DQS must be monotonic slope.
2. Differential signal falling edge from VIHdiff\_DQS to VILdiff\_DQS must be monotonic slope.

**Differential Input Slew Rate Definition for DQS\_t, DQS\_c**

| Description                                                   | Measured    |             | Defined by                                        |
|---------------------------------------------------------------|-------------|-------------|---------------------------------------------------|
|                                                               | from        | to          |                                                   |
| Differential input slew rate for rising edge (DQS_t - DQS_c)  | VILDiff_DQS | VIHDiff_DQS | $ VILDiff\_DQS - VIHDiff\_DQS /\Delta t_{TRdiff}$ |
| Differential input slew rate for falling edge (DQS_t - DQS_c) | VIHDiff_DQS | VILDiff_DQS | $ VILDiff\_DQS - VIHDiff\_DQS /\Delta t_{TFdiff}$ |

**Differential Input Level for DQS\_t, DQS\_c**

| Symbol      | Parameter               | DDR4-3200 |      | Unit | Note |
|-------------|-------------------------|-----------|------|------|------|
|             |                         | Min.      | Max. |      |      |
| VIHDiff_DQS | Differential Input High | 110       | -    | mV   |      |
| VILDiff_DQS | Differential Input Low  | -         | -110 | mV   |      |

**Differential Input Slew Rate for DQS\_t, DQS\_c**

| Symbol  | Parameter                    | DDR4-3200 |      | Unit | Note |
|---------|------------------------------|-----------|------|------|------|
|         |                              | Min.      | Max. |      |      |
| SRIdiff | Differential Input Slew Rate | 2.5       | 18   | V/ns |      |

## AC and DC output Measurement levels

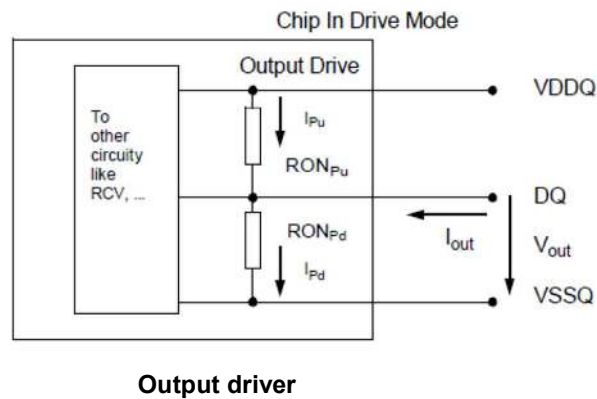
### Output Driver DC Electrical Characteristics

The DDR4 driver supports two different Ron values. These Ron values are referred as strong (low Ron) and weak mode (high Ron). A functional representation of the output buffer is shown in the figure below. Output driver impedance RON is defined as follows:

The individual pull-up and pull-down resistors ( $R_{ON_{Pu}}$  and  $R_{ON_{Pd}}$ ) are defined as follows:

$$R_{ON_{Pu}} = \frac{V_{DDQ} - V_{out}}{|I_{out}|} \quad \text{under the condition that } R_{ON_{Pd}} \text{ is off}$$

$$R_{ON_{Pd}} = \frac{V_{out}}{|I_{out}|} \quad \text{under the condition that } R_{ON_{Pu}} \text{ is off}$$



**Output Driver DC Electrical Characteristics, assuming RZQ = 240ohm; entire operating temperature range; after proper ZQ calibration**

| RON <sub>NOM</sub>                                   | Resistor | Vout             | Min  | Nom | Max  | Unit  | Note    |
|------------------------------------------------------|----------|------------------|------|-----|------|-------|---------|
| 34Ω                                                  | RON34Pd  | VOLdc= 0.5*VDDQ  | 0.73 | 1   | 1.1  | RZQ/7 | 1,2     |
|                                                      |          | VOMdc= 0.8* VDDQ | 0.83 | 1   | 1.1  | RZQ/7 | 1,2     |
|                                                      |          | VOHdc= 1.1* VDDQ | 0.83 | 1   | 1.25 | RZQ/7 | 1,2     |
|                                                      | RON34Pu  | VOLdc= 0.5* VDDQ | 0.9  | 1   | 1.25 | RZQ/7 | 1,2     |
|                                                      |          | VOMdc= 0.8* VDDQ | 0.9  | 1   | 1.1  | RZQ/7 | 1,2     |
|                                                      |          | VOHdc= 1.1* VDDQ | 0.8  | 1   | 1.1  | RZQ/7 | 1,2     |
| 48Ω                                                  | RON48Pd  | VOLdc= 0.5*VDDQ  | 0.73 | 1   | 1.1  | RZQ/5 | 1,2     |
|                                                      |          | VOMdc= 0.8* VDDQ | 0.83 | 1   | 1.1  | RZQ/5 | 1,2     |
|                                                      |          | VOHdc= 1.1* VDDQ | 0.83 | 1   | 1.25 | RZQ/5 | 1,2     |
|                                                      | RON48Pu  | VOLdc= 0.5* VDDQ | 0.9  | 1   | 1.25 | RZQ/5 | 1,2     |
|                                                      |          | VOMdc= 0.8* VDDQ | 0.9  | 1   | 1.1  | RZQ/5 | 1,2     |
|                                                      |          | VOHdc= 1.1* VDDQ | 0.8  | 1   | 1.1  | RZQ/5 | 1,2     |
| Mismatch between pull-up and pull-down, MMPuPd       |          | VOMdc= 0.8* VDDQ | -10  | -   | 17   | %     | 1,2,4,3 |
| Mismatch DQ-DQ within byte variation pull-up, MMPudd |          | VOMdc= 0.8* VDDQ | -    | -   | 10   | %     | 1,2,4   |
| Mismatch DQ-DQ within byte variation pull-dn, MMPddd |          | VOMdc= 0.8* VDDQ | -    | -   | 10   | %     | 1,2,4   |

**Note:**

- The tolerance limits are specified after calibration with stable voltage and temperature. For the behavior of the tolerance limits if temperature or voltage changes after calibration, see following section on voltage and temperature sensitivity(TBD).
- Pull-up and pull-dn output driver impedances are recommended to be calibrated at 0.8 \* VDDQ. Other calibration schemes may be used to achieve the linearity spec shown above, e.g., calibration at 0.5 \* VDDQ and 1.1 \* VDDQ.
- Measurement definition for mismatch between pull-up and pull-down, MMPuPd : Measure RONPu and RONPD both at 0.8\*VDD separately; Ronnom is the nominal Ron value

$$MMPuPd = \frac{RONPu - RONPD}{RONNOM} * 100$$

- RON variance range ratio to RON Nominal value in a given component, including DQS\_t and DQS\_c.

$$MMPudd = \frac{RONPuMax - RONPuMin}{RONNOM} * 100$$

$$MMPddd = \frac{RONPdMax - RONPdMin}{RONNOM} * 100$$

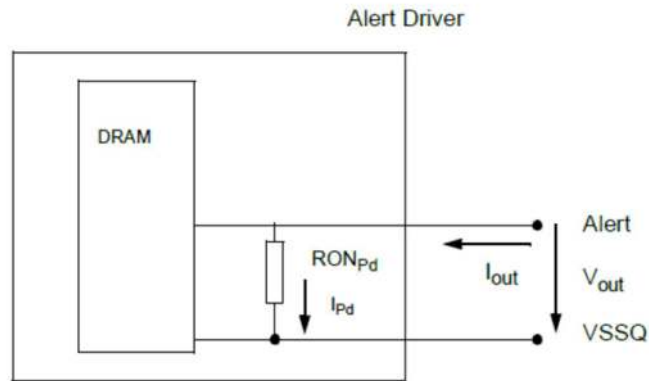
- This parameter of x16 device is specified for Upper byte and Lower byte.



### Alert\_n output Drive Characteristic

A functional representation of the output buffer is shown in the figure below. Output driver impedance  $R_{ON}$  is defined as follows:

$$R_{ON_{Pd}} = \frac{V_{out}}{|I_{out}|} \quad \text{under the condition that } R_{ON_{Pu}} \text{ is off}$$



**Functional Representation of the Output Buffer**

### Output Driver Impedance

| Resistor      | Vout                    | Min | Max | Unit | Note |
|---------------|-------------------------|-----|-----|------|------|
| $R_{ON_{Pd}}$ | $V_{OLdc} = 0.1 * VDDQ$ | 0.3 | 1.2 | 34Ω  | 1    |
|               | $V_{OMdc} = 0.8 * VDDQ$ | 0.4 | 1.2 | 34Ω  | 1    |
|               | $V_{OHdc} = 1.1 * VDDQ$ | 0.4 | 1.4 | 34Ω  | 1    |

**Note:**

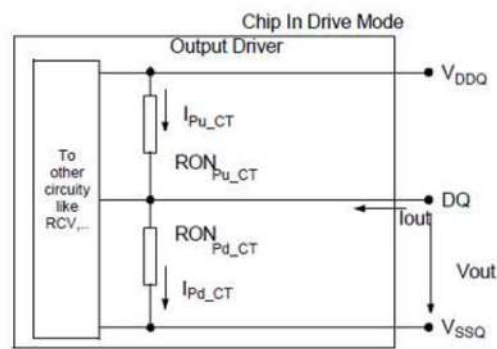
1. VDDQ voltage is at VDDQ DC. VDDQ DC definition is tbd.

## Output Driver Characteristic of Connectivity Test (CT) Mode

Following Output driver impedance RON will be applied Test Output Pin during Connectivity Test (CT) Mode. The individual pull-up and pull-down resistors (RONPu\_CT and RONPd\_CT) are defined as follows:

$$RON_{Pu\_CT} = \frac{V_{DDQ} - V_{OUT}}{|I_{out}|}$$

$$RON_{Pd\_CT} = \frac{V_{OUT}}{|I_{out}|}$$



**Output Driver**

### RONPu\_CT and RONPd\_CT

| RON <sub>NOM_CT</sub> | Resistor             | Vout                                       | Max | Unit | Note |
|-----------------------|----------------------|--------------------------------------------|-----|------|------|
| 34Ω                   | RON <sub>Pd_CT</sub> | VOB <sub>dc</sub> = 0.2 x V <sub>DDQ</sub> | 1.9 | 34Ω  | 1    |
|                       |                      | VOL <sub>dc</sub> = 0.5 x V <sub>DDQ</sub> | 2.0 | 34Ω  | 1    |
|                       |                      | VOM <sub>dc</sub> = 0.8 x V <sub>DDQ</sub> | 2.2 | 34Ω  | 1    |
|                       |                      | VOH <sub>dc</sub> = 1.1 x V <sub>DDQ</sub> | 2.5 | 34Ω  | 1    |
|                       | RON <sub>Pu_CT</sub> | VOB <sub>dc</sub> = 0.2 x V <sub>DDQ</sub> | 2.5 | 34Ω  | 1    |
|                       |                      | VOL <sub>dc</sub> = 0.5 x V <sub>DDQ</sub> | 2.2 | 34Ω  | 1    |
|                       |                      | VOM <sub>dc</sub> = 0.8 x V <sub>DDQ</sub> | 2.0 | 34Ω  | 1    |
|                       |                      | VOH <sub>dc</sub> = 1.1 x V <sub>DDQ</sub> | 1.9 | 34Ω  | 1    |

**Note:**

- Connectivity test mode uses un-calibrated drivers, showing the full range over PVT. No mismatch between pull up and pull down is defined.

## Single-ended AC & DC Output Levels

### Single-ended AC & DC output levels

| Symbol       | Parameter                                                 | DDR4-3200                     | Unit | Note |
|--------------|-----------------------------------------------------------|-------------------------------|------|------|
| $V_{OH}(DC)$ | DC output high measurement level (for IV curve linearity) | $1.1 \times V_{DDQ}$          | V    |      |
| $V_{OM}(DC)$ | DC output mid measurement level (for IV curve linearity)  | $0.8 \times V_{DDQ}$          | V    |      |
| $V_{OL}(DC)$ | DC output low measurement level (for IV curve linearity)  | $0.5 \times V_{DDQ}$          | V    |      |
| $V_{OH}(AC)$ | AC output high measurement level (for output SR)          | $(0.7 + 0.15) \times V_{DDQ}$ | V    | 1    |
| $V_{OL}(AC)$ | AC output low measurement level (for output SR)           | $(0.7 - 0.15) \times V_{DDQ}$ | V    | 1    |

**Note:**

1. The swing of  $\pm 0.15 \times V_{DDQ}$  is based on approximately 50% of the static single-ended output peak-to-peak swing with a driver impedance of  $R_{ZQ}/7\Omega$  and an effective test load of  $50\Omega$  to  $V_{TT} = V_{DDQ}$ .

### Differential AC & DC output levels

| Symbol           | Parameter                                                     | DDR4-3200             | Unit | Note |
|------------------|---------------------------------------------------------------|-----------------------|------|------|
| $V_{OHdiff}(AC)$ | AC differential output high measurement level (for output SR) | $+0.3 \times V_{DDQ}$ | V    | 1    |
| $V_{OLdiff}(AC)$ | AC differential output low measurement level (for output SR)  | $-0.3 \times V_{DDQ}$ | V    | 1    |

**Note:**

1. The swing of  $\pm 0.3 \times V_{DDQ}$  is based on approximately 50% of the static differential output peak-to-peak swing with a driver impedance of  $R_{ZQ}/7\Omega$  and an effective test load of  $50\Omega$  to  $V_{TT} = V_{DDQ}$  at each of the differential outputs.

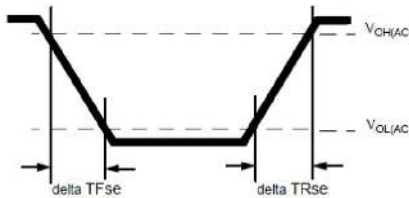
## Single-ended Output Slew Rate

With the reference load for timing measurements, output slew rate for falling and rising edges is defined and measured between  $V_{OL(AC)}$  and  $V_{OH(AC)}$  for single ended signals as shown in Single-ended output slew rate definition table and Single-ended Output Slew Rate Definition figure.

### Single-ended output slew rate definition

| Description                                    | Measured     |              | Defined by                                |
|------------------------------------------------|--------------|--------------|-------------------------------------------|
|                                                | from         | to           |                                           |
| Single ended output slew rate for rising edge  | $V_{OL(AC)}$ | $V_{OH(AC)}$ | $[V_{OH(AC)} - V_{OL(AC)}] / \Delta TRse$ |
| Single ended output slew rate for falling edge | $V_{OH(AC)}$ | $V_{OL(AC)}$ | $[V_{OH(AC)} - V_{OL(AC)}] / \Delta TFse$ |

**Note:** Output slew rate is verified by design and characterization, and may not be subject to production test.



**Single-ended Output Slew Rate Definition**

### Single-ended output slew rate

| Parameter                     | Symbol | DDR4-3200 |     | Unit |
|-------------------------------|--------|-----------|-----|------|
|                               |        | Min       | Max |      |
| Single ended output slew rate | SRQse  | 4         | 9   | V/ns |

Description: SR: Slew Rate

Q: Query Output (like in DQ, which stands for Data-in, Query-Output)

se: Single-ended Signals

For Ron = RZQ/7 setting

**Note:** 1 In two cases, a maximum slew rate of 12 V/ns applies for a single DQ signal within a byte lane.

-Case 1 is defined for a single DQ signal within a byte lane which is switching into a certain direction (either from high to low or low to high) while all remaining DQ signals in the same byte lane are static (i.e., they stay at either high or low).

-Case 2 is defined for a single DQ signal within a byte lane which is switching into a certain direction (either from high to low or low to high) while all remaining DQ signals in the same byte lane are switching into the opposite direction (i.e., from low to high or high to low respectively). For the remaining DQ signal switching into the opposite direction, the regular maximum limit of 9 V/ns applies

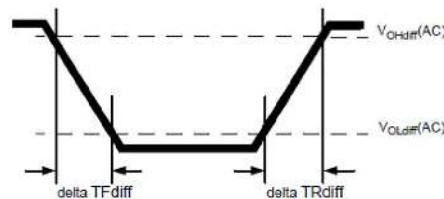
## Differential Output Slew Rate

With the reference load for timing measurements, output slew rate for falling and rising edges is defined and measured between VOLdiff(AC) and VOHdiff(AC) for differential signals as shown in Differential output slew rate definition table and Differential Output Slew Rate Definition figure.

### Differential output slew rate definition

| Description                                    | Measured    |             | Defined by                                             |
|------------------------------------------------|-------------|-------------|--------------------------------------------------------|
|                                                | from        | to          |                                                        |
| Differential output slew rate for rising edge  | VOLdiff(AC) | VOHdiff(AC) | $[V_{OHdiff}(AC) - V_{OLdiff}(AC)] / \Delta TR_{diff}$ |
| Differential output slew rate for falling edge | VOHdiff(AC) | VOLdiff(AC) | $[V_{OHdiff}(AC) - V_{OLdiff}(AC)] / \Delta TF_{diff}$ |

**Note:** Output slew rate is verified by design and characterization, and may not be subject to production test.



**Differential Output Slew Rate Definition**

### Differential output slew rate

| Parameter                     | Symbol  | DDR4-3200 |     | Unit |
|-------------------------------|---------|-----------|-----|------|
|                               |         | Min       | Max |      |
| Differential output slew rate | SRQdiff | 8         | 18  | V/ns |

Description:

SR: Slew Rate

Q: Query Output (like in DQ, which stands for Data-in, Query Output) diff: Differential Signals

For Ron = RZQ/7 setting

## Single-ended AC & DC Output Levels of Connectivity Test Mode

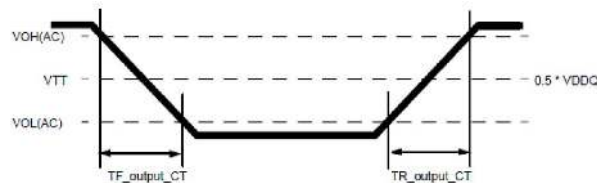
Following output parameters will be applied for DDR4 SDRAM Output Signal during Connectivity Test Mode.

### Single-ended AC & DC output levels of Connectivity Test Mode

| Symbol       | Parameter                                                  | DDR4-3200                       | Unit | Note |
|--------------|------------------------------------------------------------|---------------------------------|------|------|
| $V_{OH(DC)}$ | DC output high measurement level (for IV curve linearity)  | $1.1 \times V_{DDQ}$            | V    |      |
| $V_{OM(DC)}$ | DC output mid measurement level (for IV curve linearity)   | $0.8 \times V_{DDQ}$            | V    |      |
| $V_{OL(DC)}$ | DC output low measurement level (for IV curve linearity)   | $0.5 \times V_{DDQ}$            | V    |      |
| $V_{OB(DC)}$ | DC output below measurement level (for IV curve linearity) | $0.2 \times V_{DDQ}$            | V    |      |
| $V_{OH(AC)}$ | AC output high measurement level (for output SR)           | $V_{TT} + (0.1 \times V_{DDQ})$ | V    | 1    |
| $V_{OL(AC)}$ | AC output below measurement level (for output SR)          | $V_{TT} - (0.1 \times V_{DDQ})$ | V    | 1    |

#### Note:

- The effective test load is  $50\Omega$  terminated by  $V_{TT} = 0.5 \times V_{DDQ}$ .



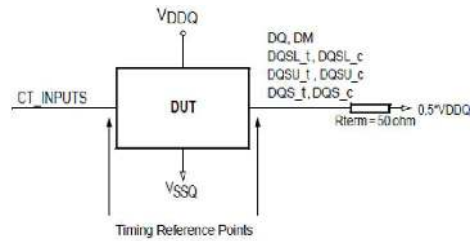
Output Slew Rate Definition of Connectivity Test Mode

### Single-ended output slew rate of Connectivity Test Mode

| Parameter                  | Symbol              | DDR4-3200 |     | Unit | Note |
|----------------------------|---------------------|-----------|-----|------|------|
|                            |                     | Min       | Max |      |      |
| Output signal Falling time | $T_{F\_output\_CT}$ | -         | 10  | ns/V |      |
| Output signal Rising time  | $T_{R\_output\_CT}$ | -         | 10  | ns/V |      |

## Test Load for Connectivity Test Mode Timing

The reference load for ODT timings is defined in Connectivity Test Mode Timing Reference Load figure.



**Connectivity Test Mode Timing Reference Load**

## Speed Bin

### DDR4-3200 Speed Bins and Operations

| Speed Bin                                                 |         |          | DDR4-3200          |                    | Unit | Note      |
|-----------------------------------------------------------|---------|----------|--------------------|--------------------|------|-----------|
| CL-nRCD-nRP                                               |         |          | 22-22-22           |                    |      |           |
| Parameter                                                 | Symbol  |          | min                | max                |      |           |
| Internal read command to first data                       | tAA     |          | 13.75              | 18.00              | ns   | 7         |
| Internal read command to first data with read DBI enabled | tAA_DBI |          | tAA(min)<br>+ 4nCK | tAA(max)<br>+ 4nCK | ns   | 7         |
| ACT to internal read or write delay time                  | tRCD    |          | 13.75              | -                  | ns   | 7         |
| PRE command period                                        | tRP     |          | 13.75              | -                  | ns   | 7         |
| ACT to PRE command period                                 | tRAS    |          | 32                 | 9 x tREFI          | ns   | 7         |
| ACT to ACT or REF command period                          | tRC     |          | 45.75              | -                  | ns   | 7         |
|                                                           | Normal  | Read DBI |                    |                    |      |           |
| CWL<br>= 9                                                | CL = 9  | CL = 11  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 10 | CL = 12  | tCK(AVG)           | 1.5      1.6       | ns   | 1,2,3,5,6 |
| CWL<br>= 9,11                                             | CL = 10 | CL = 12  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 11 | CL = 13  | tCK(AVG)           | 1.25      <1.5     | ns   | 1,2,3,5   |
|                                                           | CL = 12 | CL = 14  | tCK(AVG)           | 1.25      <1.5     | ns   | 1,2,3,5   |
| CWL<br>= 10,12                                            | CL = 12 | CL = 14  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 13 | CL = 15  | tCK(AVG)           | 1.071      <1.25   | ns   | 1,2,3,5   |
|                                                           | CL = 14 | CL = 16  | tCK(AVG)           | 1.071      <1.25   | ns   | 1,2,3,5   |
| CWL<br>= 11,14                                            | CL = 14 | CL = 17  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 15 | CL = 18  | tCK(AVG)           | 0.937      <1.071  | ns   | 1,2,3,5   |
|                                                           | CL = 16 | CL = 19  | tCK(AVG)           | 0.937      <1.071  | ns   | 1,2,3,5   |
| CWL<br>= 12,16                                            | CL = 15 | CL = 18  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 16 | CL = 19  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 17 | CL = 20  | tCK(AVG)           | 0.833      <0.937  | ns   | 1,2,3,5   |
|                                                           | CL = 18 | CL = 21  | tCK(AVG)           | 0.833      <0.937  | ns   | 1,2,3,5   |
| CWL<br>= 14,18                                            | CL = 17 | CL = 20  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 18 | CL = 21  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 19 | CL = 22  | tCK(AVG)           | 0.75      <0.833   | ns   | 1,2,3,5   |
|                                                           | CL = 20 | CL = 23  | tCK(AVG)           | 0.75      <0.833   | ns   | 1,2,3,5   |
| CWL<br>= 16, 20                                           | CL = 20 | CL = 24  | tCK(AVG)           | Reserved           | ns   | 4         |
|                                                           | CL = 21 | CL = 25  | tCK(AVG)           | 0.682      <0.75   | ns   | 1,2,3,5   |
|                                                           | CL = 22 | CL = 26  | tCK(AVG)           | 0.682      <0.75   | ns   | 1,2,3,5   |
|                                                           | CL = 24 | CL = 28  | tCK(AVG)           | 0.682      <0.75   | ns   | 1,2,3,5   |



| Speed Bin                           |         |         |          | DDR4-3200                                 |        | Unit | Note  |
|-------------------------------------|---------|---------|----------|-------------------------------------------|--------|------|-------|
| CL-nRCD-nRP                         |         |         |          | 22-22-22                                  |        |      |       |
| Parameter                           |         |         | Symbol   | min                                       | max    |      |       |
| CWL<br>=<br>16, 20                  | CL = 20 | CL = 24 | tCK(AVG) | Reserved                                  |        | ns   | 4     |
|                                     | CL = 22 | CL = 26 | tCK(AVG) | 0.625                                     | <0.682 | ns   | 1,2,3 |
|                                     | CL = 24 | CL = 28 | tCK(AVG) | 0.625                                     | <0.682 | ns   | 1,2,3 |
| Supported CL Settings               |         |         |          | 10,11,12,13,14,15,16,17,18,19,20,21,22,24 |        | nCK  |       |
| Supported CL Settings with read DBI |         |         |          | 12,13,14,15,16,18,19,20,21,22,23,25,26,28 |        | nCK  |       |
| Supported CWL Settings              |         |         |          | 9,10,11,12,14,16,18,20                    |        | nCK  |       |

### Speed Bin Table Notes

#### Absolute Specification

- VDDQ = VDD = 1.20V +/- 0.06 V
- VPP = 2.5V +0.25/-0.125 V
- The values defined with above-mentioned table are DLL ON case.
- DDR4-1600, 1866, 2133 and 2400 Speed Bin Tables are valid only when Geardown Mode is disabled.

#### Note:

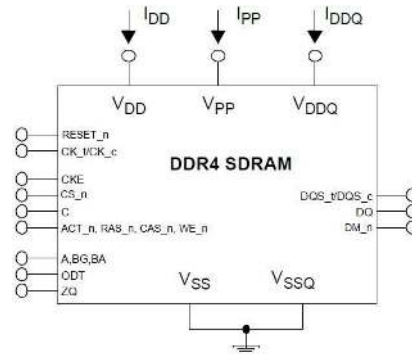
1. The CL setting and CWL setting result in tCK(avg).MIN and tCK(avg).MAX requirements. When making a selection of tCK(avg), both need to be fulfilled: Requirements from CL setting as well as requirements from CWL setting.
2. tCK(avg).MIN limits: Since CAS Latency is not purely analog - data and strobe output are synchronized by the DLL - all possible intermediate frequencies may not be guaranteed. CL in clock cycle is calculated from tAA following rounding algorithm defined.
3. tCK(avg).MAX limits: Calculate tCK(avg) = tAA.MAX / CL SELECTED and round the resulting tCK(avg) down to the next valid speed bin (i.e., 1.5ns or 1.25ns or 1.071 ns or 0.937 ns or 0.833 ns or 0.75 ns or 0.682 ns). This result is tCK(avg).MAX corresponding to CL SELECTED.
4. 'Reserved' settings are not allowed. User must program a different value.
5. Any DDR4-3200 speed bin also supports functional operation at lower frequencies as shown in the table which are not subject to Production Tests but verified by Design/Characterization.
6. DDR4-1600 AC timing apply if DRAM operates at lower than 1600 MT/s data rate.
7. Parameters apply from tCK(avg)min to tCK(avg)max at all standard JEDEC clock period values as stated in the Speed Bin Tables.

## IDD and IDDQ Specification Parameters and Test conditions

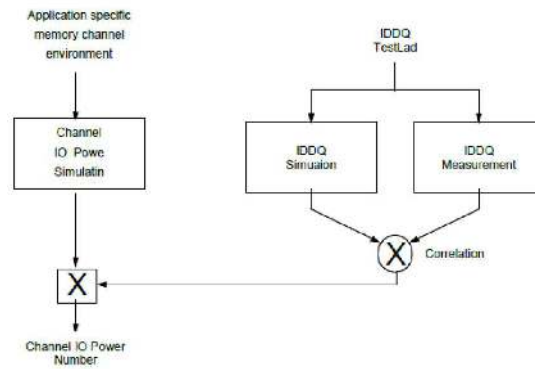
### IDD, IPP and IDDQ Measurement Conditions

In this chapter, IDD, IPP and IDDQ measurement conditions such as test load and patterns are defined. Measurement Setup and Test Load for IDD, IPP and IDDQ Measurements figure shows the setup and test load for IDD, IPP and IDDQ measurements.

- IDD currents (such as IDD0, IDD0A, IDD1, IDD1A, IDD2N, IDD2NA, IDD2NL, IDD2NT, IDD2P, IDD2Q, IDD3N, IDD3NA, IDD3P, IDD4R, IDD4RA, IDD4W, IDD4WA, IDD5B, IDD5F2, IDD5F4, IDD6N, IDD6E, IDD6R, IDD6A, IDD7 and IDD8) are measured as time-averaged currents with all VDD balls of the DDR4 SDRAM under test tied together. Any IPP or IDDQ current is not included in IDD currents.
- IPP currents have the same definition as IDD except that the current on the VPP supply is measured.
- IDDQ currents are measured as time-averaged currents with all VDDQ balls of the DDR4 SDRAM under test tied together. Any IDD current is not included in IDDQ currents.  
Attention: IDDQ values cannot be directly used to calculate IO power of the DDR4 SDRAM. They can be used to support correlation of simulated IO power to actual IO power as outlined in Correlation from simulated Channel IO Power to actual Channel IO Power supported by IDDQ Measurement figure. In DRAM module application, IDDQ cannot be measured separately since VDD and VDDQ are using one merged-power layer in Module PCB.
- For IDD, IPP and IDDQ measurements, the following definitions apply:
- “0” and “LOW” is defined as  $V_{IN} \leq V_{ILAC}(\max)$ .
- “1” and “HIGH” is defined as  $V_{IN} \geq V_{IHAC}(\min)$ .
- “MID-LEVEL” is defined as inputs are  $V_{REF} = V_{DD} / 2$ .
- Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns are provided in Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table.
- Basic IDD, IPP and IDDQ Measurement Conditions are described in Table .
- Detailed IDD, IPP and IDDQ Measurement-Loop Patterns are described in IDD0, IDD0A and IPP0 Measurement-Loop Pattern<sup>1</sup> table through IDD7 Measurement-Loop Pattern<sup>1</sup> table.
- IDD Measurements are done after properly initializing the DDR4 SDRAM. This includes but is not limited to setting  
RON = RZQ/7 (34 Ohm in MR1);  
RTT\_NOM = RZQ/6 (40 Ohm in MR1);  
RTT\_WR = RZQ/2 (120 Ohm in MR2);  
RTT\_PARK = Disable;  
Qoff = 0B (Output Buffer enabled) in MR1;  
TDQS\_t disabled in MR1;  
CRC disabled in MR2;  
CA parity feature disabled in MR5;  
Gear down mode disabled in MR3;  
Read/Write DBI disabled in MR5;  
DM disabled in MR5
- Attention: The IDD, IPP and IDDQ Measurement-Loop Patterns need to be executed at least one time before actual IDD or IDDQ measurement is started.
- Define D = {CS\_n, ACT\_n, RAS\_n, CAS\_n, WE\_n} := {HIGH, LOW, LOW, LOW, LOW} ; apply BG/BA changes when directed.
- Define D# = {CS\_n, ACT\_n, RAS\_n, CAS\_n, WE\_n} := {HIGH, HIGH, HIGH, HIGH, HIGH} ; apply invert of BG/BA changes when directed above.



**Measurement Setup and Test Load for  $I_{DD}$ ,  $I_{PP}$  and  $I_{DDQ}$  Measurements**



**Correlation from simulated Channel IO Power to actual Channel IO Power supported by  $I_{DDQ}$**

**Measurement Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns**

| Symbol     | DDR4-3200 (22-22-22) | Unit |
|------------|----------------------|------|
| tCK        | 0.625                | ns   |
| CL         | 22                   | nCK  |
| CWL        | 20                   | nCK  |
| nRCD       | 22                   | nCK  |
| nRC        | 74                   | nCK  |
| nRAS       | 52                   | nCK  |
| nRP        | 22                   | nCK  |
| nFAW (x8)  | 34                   | nCK  |
| nRRDS (x8) | 4                    | nCK  |
| nRRDL (x8) | 8                    | nCK  |
| tCCD_S     | 4                    | nCK  |
| tCCD_L     | 8                    | nCK  |
| tWTR_S     | 4                    | nCK  |
| tWTR_L     | 12                   | nCK  |
| nRFC 8Gb   | 416                  | nCK  |

**Basic IDD, IPP and IDDQ Measurement Conditions**

| Symbol    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| IDD0      | <b>Operating One Bank Active-Precharge Current (AL=0)</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, nRC, nRAS, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns (cont'd) table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> High between ACT and PRE; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to <b>IDD0, IDD0A and IPP0 Measurement-Loop Pattern<sup>1</sup></b> table; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> Cycling with one bank active at a time: 0,0,1,1,2,2,... (see <b>IDD0, IDD0A and IPP0 Measurement-Loop Pattern<sup>1</sup></b> table); <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see <b>IDD0, IDD0A and IPP0 Measurement-Loop Pattern<sup>1</sup></b> table.  |
| IDD0A     | <b>Operating One Bank Active-Precharge Current (AL=CL-1) AL = CL-1, Other conditions:</b> see <b>IDD0</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| IPP0      | <b>Operating One Bank Active-Precharge IPP Current</b><br><b>Same condition with IDD0</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| IDD1      | <b>Operating One Bank Active-Read-Precharge Current (AL=0)</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, nRC, nRAS, nRCD, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns (cont'd) table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> High between ACT, RD and PRE; <b>Command, Address, Bank Group Address, Bank Address Inputs, Data IO:</b> partially toggling according to <b>IDD1, IDD1A and IPP1 Measurement-Loop Pattern<sup>1</sup></b> table; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> Cycling with one bank active at a time: 0,0,1,1,2,2,... (see <b>IDD1, IDD1A and IPP1 Measurement-Loop Pattern<sup>1</sup></b> table); <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see <b>IDD1, IDD1A and IPP1 Measurement-Loop Pattern<sup>1</sup></b> table |
| IDD1A     | <b>Operating One Bank Active-Read-Precharge Current (AL=CL-1) AL = CL-1, Other conditions:</b> see <b>IDD1</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| IPP1      | <b>Operating One Bank Active-Read-Precharge IPP Current</b><br><b>Same condition with IDD1</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| IDD2N     | <b>Precharge Standby Current (AL=0)</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns (cont'd) table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> stable at 1; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to <b>IDD2N, IDD2NA, IDD2NL, IDD2NG, IDD2ND, IDD2N_par, IPP2, IDD3N, IDD3NA and IDD3P</b> table; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks closed; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see <b>IDD2N, IDD2NA, IDD2NL, IDD2NG, IDD2ND, IDD2N_par, IPP2, IDD3N, IDD3NA and IDD3P</b> table                                                                                                                     |
| IDD2NA    | <b>Precharge Standby Current (AL=CL-1) AL = CL-1, Other conditions:</b> see <b>IDD2N</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| IPP2N     | <b>Precharge Standby IPP Current</b><br><b>Same condition with IDD2N</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| IDD2NT    | <b>Precharge Standby ODT Current</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns (cont'd) table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> stable at 1; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to <b>IDD2NT Measurement-Loop Pattern<sup>1</sup></b> table; <b>Data IO:</b> VSSQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks closed; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> toggling according to <b>IDD2NT Measurement-Loop Pattern<sup>1</sup></b> table; <b>Pattern Details:</b> see <b>IDD2NT Measurement-Loop Pattern<sup>1</sup></b> table                                                                                                                             |
| IDD2NL    | <b>Precharge Standby Current with CAL enabled</b><br>Same definition like for <b>IDD2N</b> , CAL enabled <sup>3</sup>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| IDD2NG    | <b>Precharge Standby Current with Gear Down mode enabled</b><br>Same definition like for <b>IDD2N</b> , Gear Down mode enabled <sup>3,5</sup>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| IDD2ND    | <b>Precharge Standby Current with DLL disabled</b><br>Same definition like for <b>IDD2N</b> , DLL disabled <sup>3</sup>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| IDD2N_par | <b>Precharge Standby Current with CA parity enabled</b><br>Same definition like for <b>IDD2N</b> , CA parity enabled <sup>3</sup>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |

| Symbol | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| IDD2P  | <b>Precharge Power-Down Current</b> <b>CKE:</b> Low; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns (cont'd) table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> stable at 1; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> stable at 0; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks closed; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| IPP2P  | <b>Precharge Power-Down IPP Current</b><br>Same condition with IDD2P                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| IDD2Q  | <b>Precharge Quiet Standby Current</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns (cont'd) table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> stable at 1; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> stable at 0; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks closed; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| IDD3N  | <b>Active Standby Current</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> stable at 1; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to IDD2N, IDD2NA, IDD2NL, IDD2NG, IDD2ND, IDD2N_par, IPP2, IDD3N, IDD3NA and IDD3P table; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks open; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see IDD2N, IDD2NA, IDD2NL, IDD2NG, IDD2ND, IDD2N_par, IPP2, IDD3N, IDD3NA and IDD3P table                                                                                                                                                                                                                                                                                                                      |
| IDD3NA | <b>Active Standby Current (AL=CL-1)</b><br><b>AL = CL-1, Other conditions:</b> see IDD3N                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| IPP3N  | <b>Active Standby IPP Current</b><br>Same condition with IDD3N                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| IDD3P  | <b>Active Power-Down Current</b><br><b>CKE:</b> Low; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> stable at 1; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> stable at 0; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks open; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| IPP3P  | <b>Active Power-Down IPP Current</b><br>Same condition with IDD3P                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| IDD4R  | <b>Operating Burst Read Current</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>2</sup> ; <b>AL:</b> 0; <b>CS_n:</b> High between RD; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to IDD4R, IDDR4RA and IDD4RB Measurement-Loop Pattern <sup>1</sup> table; <b>Data IO:</b> seamless read data burst with different data between one burst and the next one according to IDD4R, IDDR4RA and IDD4RB Measurement-Loop Pattern <sup>1</sup> table; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks open, RD commands cycling through banks: 0,0,1,1,2,2,... (see IDD4R, IDDR4RA and IDD4RB Measurement-Loop Pattern <sup>1</sup> table); <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see IDD4R, IDDR4RA and IDD4RB Measurement-Loop Pattern <sup>1</sup> table                                              |
| IDD4RA | <b>Operating Burst Read Current (AL=CL-1)</b> <b>AL = CL-1, Other conditions:</b> see IDD4R                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| IDD4RB | <b>Operating Burst Read Current with Read DBI Read DBI enabled<sup>3</sup>, Other conditions:</b> see IDD4R                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| IPP4R  | <b>Operating Burst Read IPP Current</b><br>Same condition with IDD4R                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| IDD4W  | <b>Operating Burst Write Current</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> High between WR; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to IDD4W, IDD4WA, IDD4WB and IDD4W_par Measurement-Loop Pattern <sup>1</sup> table; <b>Data IO:</b> seamless write data burst with different data between one burst and the next one according to IDD4W, IDD4WA, IDD4WB and IDD4W_par Measurement-Loop Pattern <sup>1</sup> table; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> all banks open, WR commands cycling through banks: 0,0,1,1,2,2,... (see IDD4W, IDD4WA, IDD4WB and IDD4W_par Measurement-Loop Pattern <sup>1</sup> table); <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at HIGH; <b>Pattern Details:</b> see IDD4W, IDD4WA, IDD4WB and IDD4W_par Measurement-Loop Pattern <sup>1</sup> table |

| Symbol    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| IDD4WA    | <b>Operating Burst Write Current (AL=CL-1) AL = CL-1, Other conditions:</b> see IDD4W                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| IDD4WB    | <b>Operating Burst Write Current with Write DBI Write DBI enabled<sup>3</sup>, Other conditions:</b> see IDD4W                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| IDD4WC    | <b>Operating Burst Write Current with Write CRC Write CRC enabled<sup>3</sup>, Other conditions:</b> see IDD4W                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| IDD4W_par | <b>Operating Burst Write Current with CA Parity CA Parity enabled<sup>3</sup>, Other conditions:</b> see IDD4W                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| IPP4W     | <b>Operating Burst Write IPP Current Same condition with IDD4W</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| IDD5B     | <b>Burst Refresh Current (1X REF)</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, CL, nRFC:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n:</b> High between REF; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to IDD5B Measurement-Loop Pattern <sup>1</sup> table; <b>Data IO:</b> VDDQ; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> REF command every nRFC (see IDD5B Measurement-Loop Pattern <sup>1</sup> table); <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see IDD5B Measurement-Loop Pattern <sup>1</sup> table |
| IPP5B     | <b>Burst Refresh Write IPP Current (1X REF) Same condition with IDD5B</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| IDD5F2    | <b>Burst Refresh Current (2X REF) tRFC=tRFC_x2, Other conditions:</b> see IDD5B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| IPP5F2    | <b>Burst Refresh Write IPP Current (2X REF) Same condition with IDD5F2</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| IDD5F4    | <b>Burst Refresh Current (4X REF) tRFC=tRFC_x4, Other conditions:</b> see IDD5B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| IPP5F4    | <b>Burst Refresh Write IPP Current (4X REF) Same condition with IDD5F4</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| IDD6N     | <b>Self Refresh Current: Normal Temperature Range</b><br><b>T<sub>CASE</sub> for devices:</b> 0 to 85°C or -40 to 85°C; <b>Low Power Auto Self Refresh (LP ASR) :</b> Normal <sup>4</sup> ; <b>CKE:</b> Low; <b>External clock:</b> Off; <b>CK_t and CK_c#:</b> LOW; <b>CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n#, Command, Address, Bank Group Address, Bank Address, Data IO:</b> High; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> Self-Refresh operation; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> MID-LEVEL                                                                                               |
| IPP6N     | <b>Self Refresh IPP Current: Normal Temperature Range Same condition with IDD6N</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| IDD6E     | <b>Self-Refresh Current: Extended Temperature Range)</b><br><b>T<sub>CASE</sub> for devices:</b> 0 to 95°C or -40 to 95°C; <b>Low Power Auto Self Refresh (LP ASR) :</b> Extended <sup>4</sup> ; <b>CKE:</b> Low; <b>External clock:</b> Off; <b>CK_t and CK_c#:</b> LOW; <b>CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n, Command, Address, Bank Group Address, Bank Address, Data IO:</b> High; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> Extended Temperature Self-Refresh operation; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> MID-LEVEL                                                                      |
| IPP6E     | <b>Self Refresh IPP Current: Extended Temperature Range Same condition with IDD6E</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| IDD6R     | <b>Self-Refresh Current: Reduced Temperature Range</b><br><b>T<sub>CASE</sub> for CT devices:</b> 0 to 45°C or -40 to 45°C; <b>Low Power Auto Self Refresh (LP ASR) :</b> Reduced <sup>4</sup> ; <b>CKE:</b> Low; <b>External clock:</b> Off; <b>CK_t and CK_c#:</b> LOW; <b>CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n#, Command, Address, Bank Group Address, Bank Address, Data IO:</b> High; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> Extended Temperature Self-Refresh operation; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> MID-LEVEL                                                                     |
| IPP6R     | <b>Self Refresh IPP Current: Reduced Temperature Range Same condition with IDD6R</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |



| Symbol | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| IDD6A  | <b>Auto Self-Refresh Current</b><br><b>T<sub>CASE</sub> for CT devices:</b> 0 to 95°C or -40 to 95°C; <b>Low Power Auto Self Refresh (LP ASR)</b> : Auto <sup>4</sup> ; <b>CKE:</b> Low; <b>External clock:</b> Off; CK_t and CK_# : LOW; <b>CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> 0; <b>CS_n#, Command, Address, Bank Group Address, Bank Address, Data IO:</b> High; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> Auto Self-Refresh operation; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> MID-LEVEL                                                                                                                                                                                                                                                                                                                                                       |
| IPP6A  | <b>Auto Self-Refresh IPP Current</b><br><b>Same condition with IDD6A</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| IDD7   | <b>Operating Bank Interleave Read Current</b><br><b>CKE:</b> High; <b>External clock:</b> On; <b>tCK, nRC, nRAS, nRCD, nRRD, nFAW, CL:</b> see Timings used for IDD, IPP and IDDQ Measurement-Loop Patterns table; <b>BL:</b> 8 <sup>1</sup> ; <b>AL:</b> CL-1; <b>CS_n:</b> High between ACT and RDA; <b>Command, Address, Bank Group Address, Bank Address Inputs:</b> partially toggling according to IDD7 Measurement-Loop Pattern <sup>1</sup> table; <b>Data IO:</b> read data bursts with different data between one burst and the next one according to IDD7 Measurement-Loop Pattern <sup>1</sup> table; <b>DM_n:</b> stable at 1; <b>Bank Activity:</b> two times interleaved cycling through banks (0, 1, ...7) with different addressing, see IDD7 Measurement-Loop Pattern <sup>1</sup> table; <b>Output Buffer and RTT:</b> Enabled in Mode Registers <sup>2</sup> ; <b>ODT Signal:</b> stable at 0; <b>Pattern Details:</b> see DD7 Measurement-Loop Pattern <sup>1</sup> table |
| IPP7   | <b>Operating Bank Interleave Read IPP Current</b><br><b>Same condition with IDD7</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| IDD8   | <b>Maximum Power Down Current</b><br><b>TBD</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| IPP8   | <b>Maximum Power Down IPP Current</b><br><b>Same condition with IDD8</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |

**Note:**

1. Burst Length: BL8 fixed by MRS: set MR0 [A1:0=0].
2. Output Buffer Enable
  - set MR1 [A12 = 0] : Qoff = Output buffer enabled
  - set MR1 [A2:1 = 00] : Output Driver Impedance Control = RZQ/7RTT\_Nom enable
  - set MR1 [A10:8 = 011] : RTT\_NOM = RZQ/6RTT\_WR enable
  - set MR2 [A10:9 = 01] : RTT\_WR = RZQ/2RTT\_PARK disable
  - set MR5 [A8:6 = 000]
3. CAL enabled : set MR4 [A8:6 = 001] : 1600MT/s  
                                010] : 1866MT/s, 2133MT/s  
                                011] : 2400MT/s  
Gear Down mode enabled :set MR3 [A3 = 1] : 1/4 Rate  
DLL disabled : set MR1 [A0 = 0]  
CA parity enabled :set MR5 [A2:0 = 001] : 1600MT/s, 1866MT/s, 2133MT/s  
                                010] : 2400MT/s  
Read DBI enabled : set MR5 [A12 = 1]  
Write DBI enabled : set :MR5 [A11 = 1]
4. Low Power Auto Self Refresh (LP ASR) : set MR2 [A7:6 = 00] : Normal  
                                                            01] : Reduced Temperature range  
                                                           10]: Extended Temperature range  
                                                           11]: Auto Self Refresh
5. IDD2NG should be measured after sync pulse (NOP) input.



**IDD0, IDD0A and IPP0 Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number | Command                                                        | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |
|------------|-------------|----------|--------------|----------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|------|
| toggling   | Static High | 0        | 0            | ACT                                                            | 0    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | 1, 2         | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | 3, 4         | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -    |
|            |             |          | ...          | repeat pattern 1...4 until nRAS - 1, truncate if necessary     |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             |          | nRAS         | PRE                                                            | 0    | 1     | 0         | 1         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | ...          | repeat nRC 1...4 until nRC - 1, truncate if necessary          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 1        | 1*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 2        | 2*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 3        | 3*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 4        | 4*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 5        | 5*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 6        | 6*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 7        | 7*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 8        | 8*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 9        | 9*nRC        | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 10       | 10*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 11       | 11*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 12       | 12*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 13       | 13*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 14       | 14*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 15       | 15*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |

**Note:**

1. DQS\_t, DQS\_c are VDDQ.
2. C[2:0] are used only for 3DS device.
3. DQ signals are VDDQ.

**IDD1, IDD1A and IPP1 Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number       | Command                                                          | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data                                                                        |
|------------|-------------|----------|--------------------|------------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|-----------------------------------------------------------------------------|
| toggling   | Static High | 0        | 0                  | ACT                                                              | 0    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                                           |
|            |             |          | 1, 2               | D, D                                                             | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                                           |
|            |             |          | 3, 4               | D#, D#                                                           | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                                           |
|            |             |          | ...                | repeat pattern 1...4 until nRCD - AL - 1, truncate if necessary  |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             |          | nRCD-AL            | RD                                                               | 0    | 1     | 1         | 0         | 1        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | D0=00,<br>D1=FF,<br>D2=FF,<br>D3=00,<br>D4=FF,<br>D5=00,<br>D6=00,<br>D7=FF |
|            |             |          | ...                | repeat pattern 1...4 until nRAS - 1, truncate if necessary       |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             |          | nRAS               | PRE                                                              | 0    | 1     | 0         | 1         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                                           |
|            |             |          | ...                | repeat pattern 1...4 until nRC - 1, truncate if necessary        |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 1        | 1*nRC + 0          | ACT                                                              | 0    | 0     | 0         | 1         | 1        | 0   | 0      | 1       | 1       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                                           |
|            |             |          | 1*nRC + 1, 2       | D, D                                                             | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                                           |
|            |             |          | 1*nRC + 3, 4       | D#, D#                                                           | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                                           |
|            |             |          | ...                | repeat pattern nRC + 1...4 until nRAS - 1, truncate if necessary |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             |          | 1*nRCD + nRCD - AL | RD                                                               | 0    | 1     | 1         | 0         | 1        | 0   | 0      | 1       | 1       | 0        | 0           | 0        | 0      | 0      | 0      | D0=FF,<br>D1=00,<br>D2=00,<br>D3=FF,<br>D4=00,<br>D5=FF,<br>D6=FF,<br>D7=00 |
|            |             |          | ...                | repeat pattern nRC + 1...4 until nRAS - 1, truncate if necessary |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             |          | 1*nRCD + nRAS      | PRE                                                              | 0    | 1     | 0         | 1         | 0        | 0   | 0      | 1       | 1       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                                           |
|            |             |          | ...                | repeat nRC + 1...4 until 2*nRC - 1, truncate if necessary        |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 2        | 2*nRC              | repeat Sub-Loop 0, use BG[1:0] = 0, BA[1:0] = 2 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 3        | 3*nRC              | repeat Sub-Loop 1, use BG[1:0] = 1, BA[1:0] = 3 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 4        | 4*nRC              | repeat Sub-Loop 0, use BG[1:0] = 0, BA[1:0] = 1 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 5        | 5*nRC              | repeat Sub-Loop 1, use BG[1:0] = 1, BA[1:0] = 2 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 6        | 6*nRC              | repeat Sub-Loop 0, use BG[1:0] = 0, BA[1:0] = 3 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 7        | 7*nRC              | repeat Sub-Loop 1, use BG[1:0] = 1, BA[1:0] = 0 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 8        | 8*nRC              | repeat Sub-Loop 1, use BG[1:0] = 2, BA[1:0] = 0 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 9        | 9*nRC              | repeat Sub-Loop 0, use BG[1:0] = 3, BA[1:0] = 1 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |
|            |             | 10       | 10*nRC             | repeat Sub-Loop 1, use BG[1:0] = 2, BA[1:0] = 2 instead          |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                             |

| CK_t, CK_c | CKE | Sub-Loop | Cycle Number | Command                                                        | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |
|------------|-----|----------|--------------|----------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|------|
|            |     | 11       | 11*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 12       | 12*nRC       | repeat Sub-Loop 1, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 13       | 13*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 14       | 14*nRC       | repeat Sub-Loop 1, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 15       | 15*nRC       | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |

**Note:**

1. DQS\_t, DQS\_c are used according to RD Commands, otherwise VDDQ.
2. C[2:0] are used only for 3DS device.
3. Burst Sequence driven on each DQ signal by Read Command. Outside burst operation, DQ signals are VDDQ.

**IDD2N, IDD2NA, IDD2NL, IDD2NG, IDD2ND, IDD2N\_par, IPP2, IDD3N, IDD3NA and IDD3P**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number | Command                                                        | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |
|------------|-------------|----------|--------------|----------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|------|
| toggling   | Static High | 0        | 0            | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | 1            | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | 2            | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -    |
|            |             |          | 3            | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -    |
|            |             | 1        | 4-7          | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 2        | 8-11         | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 3        | 12-15        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 4        | 16-19        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 5        | 20-23        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 6        | 24-27        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 7        | 28-31        | repeat Sub-Loop 0, use <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 8        | 32-35        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 9        | 36-39        | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 10       | 40-43        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 11       | 44-47        | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 12       | 48-51        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 13       | 52-55        | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 14       | 56-59        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 15       | 60-63        | repeat Sub-Loop 0, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |

**Note:**

1. DQS\_t, DQS\_c are VDDQ.
2. C[2:0] are used only for 3DS device.
3. DQ signals are VDDQ.

**IDD2NT Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number | Command                                                                    | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |
|------------|-------------|----------|--------------|----------------------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|------|
| toggling   | Static High | 0        | 0            | D, D                                                                       | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | 1            | D, D                                                                       | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -    |
|            |             |          | 2            | D#, D#                                                                     | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -    |
|            |             |          | 3            | D#, D#                                                                     | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -    |
|            |             | 1        | 4-7          | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 1, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 2        | 8-11         | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 3        | 12-15        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 4        | 16-19        | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 5        | 20-23        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 6        | 24-27        | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 7        | 28-31        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 8        | 32-35        | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 9        | 36-39        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 10       | 40-43        | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 11       | 44-47        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 12       | 48-51        | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 13       | 52-55        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 14       | 56-59        | repeat Sub-Loop 0, but ODT = 0 and <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |             | 15       | 60-63        | repeat Sub-Loop 0, but ODT = 1 and <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |

**Note:**

1. DQS\_t, DQS\_c are VDDQ.
2. C[2:0] are used only for 3DS device.
3. DQ signals are VDDQ.

**IDD4R, IDDR4RA and IDD4RB Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number | Command                                                        | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data                                                   |
|------------|-------------|----------|--------------|----------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|--------------------------------------------------------|
| toggling   | Static High | 0        | 0            | RD                                                             | 0    | 1     | 1         | 0         | 1        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | D0=00, D1=FF, D2=FF, D3=00, D4=FF, D5=00, D6=00, D7=FF |
|            |             |          | 1            | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                      |
|            |             |          | 2-3          | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                      |
|            |             | 1        | 4            | RD                                                             | 0    | 1     | 1         | 0         | 1        | 0   | 0      | 1       | 1       | 0        | 0           | 0        | 7      | F      | 0      | D0=FF, D1=00, D2=00, D3=FF, D4=00, D5=FF, D6=FF, D7=00 |
|            |             |          | 5            | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                      |
|            |             |          | 6-7          | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 0   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                      |
|            |             | 2        | 8-11         | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 3        | 12-15        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 4        | 16-19        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 5        | 20-23        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 6        | 24-27        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 7        | 28-31        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 8        | 32-35        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 9        | 36-39        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 10       | 40-43        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 11       | 44-47        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 12       | 48-51        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 13       | 52-55        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 14       | 56-59        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 15       | 60-63        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |

**Note:**

1. DQS\_t, DQS\_c are used according to RD Commands, otherwise VDDQ.
2. C[2:0] are used only for 3DS device.
3. Burst Sequence driven on each DQ signal by Read Command.

**IDD4W, IDD4WA, IDD4WB and IDD4W\_par Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number | Command                                                        | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data                                                   |
|------------|-------------|----------|--------------|----------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|--------------------------------------------------------|
| toggling   | Static High | 0        | 0            | WR                                                             | 0    | 1     | 1         | 0         | 0        | 1   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | D0=00, D1=FF, D2=FF, D3=00, D4=FF, D5=00, D6=00, D7=FF |
|            |             |          | 1            | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 1   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                      |
|            |             |          | 2-3          | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 1   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                      |
|            |             | 1        | 4            | WR                                                             | 0    | 1     | 1         | 0         | 0        | 1   | 0      | 1       | 1       | 0        | 0           | 0        | 7      | F      | 0      | D0=FF, D1=00, D2=00, D3=FF, D4=00, D5=FF, D6=FF, D7=00 |
|            |             |          | 5            | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 1   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                      |
|            |             |          | 6-7          | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 1   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                      |
|            |             | 2        | 8-11         | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 3        | 12-15        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 4        | 16-19        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 5        | 20-23        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 6        | 24-27        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 7        | 28-31        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 8        | 32-35        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 9        | 36-39        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 10       | 40-43        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 11       | 44-47        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 12       | 48-51        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 13       | 52-55        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 14       | 56-59        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |
|            |             | 15       | 60-63        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                        |

**Note:**

1. DQS\_t, DQS\_c are used according to WR Commands, otherwise VDDQ.
2. C[2:0] are used only for 3DS device.
3. Burst Sequence driven on each DQ signal by Write Command.

**IDD4WC Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE         | Sub-Loop | Cycle Number | Command                                                        | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data                                                           |
|------------|-------------|----------|--------------|----------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|----------------------------------------------------------------|
| toggling   | Static High | 0        | 0            | WR                                                             | 0    | 1     | 1         | 0         | 0        | 1   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | D0=00, D1=FF, D2=FF, D3=00, D4=FF, D5=00, D6=00, D7=FF, D8=CRC |
|            |             |          | 1-2          | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 1   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                              |
|            |             |          | 3-4          | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 1   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                              |
|            |             | 1        | 5            | WR                                                             | 0    | 1     | 1         | 0         | 0        | 1   | 0      | 1       | 1       | 0        | 0           | 0        | 7      | F      | 0      | D0=FF, D1=00, D2=00, D3=FF, D4=00, D5=FF, D6=FF, D7=00, D8=CRC |
|            |             |          | 6-7          | D, D                                                           | 1    | 0     | 0         | 0         | 0        | 1   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | -                                                              |
|            |             |          | 8-9          | D#, D#                                                         | 1    | 1     | 1         | 1         | 1        | 1   | 0      | 3       | 3       | 0        | 0           | 0        | 7      | F      | 0      | -                                                              |
|            |             | 2        | 10-14        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 3        | 15-19        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 4        | 20-24        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 5        | 25-29        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 6        | 30-34        | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 7        | 35-39        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 8        | 40-44        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 9        | 45-49        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 10       | 50-54        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 11       | 55-59        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 12       | 60-64        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 13       | 65-69        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 14       | 70-74        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |
|            |             | 15       | 75-79        | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |                                                                |

**Note:**

1. DQS\_t, DQS\_c are VDDQ.
2. C[2:0] are used only for 3DS device.
3. Burst Sequence driven on each DQ signal by Write Command.



**IDD5B Measurement-Loop Pattern<sup>1</sup>**

| CK <sub>t</sub> , CK <sub>c</sub> | CKE         | Sub-Loop | Cycle Number    | Command                                                           | CS <sub>n</sub> | ACT <sub>n</sub> | RAS <sub>n</sub> /A16 | CAS <sub>n</sub> /A15 | WE <sub>n</sub> /A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC <sub>n</sub> | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |
|-----------------------------------|-------------|----------|-----------------|-------------------------------------------------------------------|-----------------|------------------|-----------------------|-----------------------|----------------------|-----|--------|---------|---------|---------------------|-------------|----------|--------|--------|--------|------|
| toggling                          | Static High | 0        | 0               | REF                                                               | 1               | 0                | 0                     | 0                     | 0                    | 0   | 0      | 0       | 0       | 0                   | 0           | 0        | 0      | 0      | 0      | -    |
|                                   |             | 1        | 1               | D, D                                                              | 1               | 0                | 0                     | 0                     | 0                    | 0   | 0      | 0       | 0       | 0                   | 0           | 0        | 0      | 0      | 0      | -    |
|                                   |             |          | 2               | D, D                                                              | 1               | 0                | 0                     | 0                     | 0                    | 0   | 0      | 0       | 0       | 0                   | 0           | 0        | 0      | 0      | 0      | -    |
|                                   |             |          | 3               | D#, D#                                                            | 1               | 1                | 1                     | 1                     | 1                    | 0   | 0      | 3       | 3       | 0                   | 0           | 0        | 7      | F      | 0      | -    |
|                                   |             |          | 4               | D#, D#                                                            | 1               | 1                | 1                     | 1                     | 1                    | 0   | 0      | 3       | 3       | 0                   | 0           | 0        | 7      | F      | 0      | -    |
|                                   |             |          | 5-8             | repeat pattern 1...4, use <b>BG[1:0] = 1, BA[1:0] = 1</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 9-12            | repeat pattern 1...4, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 13-16           | repeat pattern 1...4, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 17-20           | repeat pattern 1...4, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 21-24           | repeat pattern 1...4, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 25-28           | repeat pattern 1...4, use <b>BG[1:0] = 0, BA[1:0] = 3</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 29-32           | repeat pattern 1...4, use <b>BG[1:0] = 1, BA[1:0] = 0</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 33-36           | repeat pattern 1...4, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 37-40           | repeat pattern 1...4, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 41-44           | repeat pattern 1...4, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 45-48           | repeat pattern 1...4, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 49-52           | repeat pattern 1...4, use <b>BG[1:0] = 2, BA[1:0] = 1</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 53-56           | repeat pattern 1...4, use <b>BG[1:0] = 3, BA[1:0] = 2</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 57-60           | repeat pattern 1...4, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             |          | 61-64           | repeat pattern 1...4, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |
|                                   |             | 2        | 65 ... nRFC - 1 | repeat Sub-Loop 0, truncate if necessary                          |                 |                  |                       |                       |                      |     |        |         |         |                     |             |          |        |        |        |      |

**Note:**

1. DQS<sub>t</sub>, DQS<sub>c</sub> are VDDQ.
2. C[2:0] are used only for 3DS device.
3. DQ signals are VDDQ.

**IDD7 Measurement-Loop Pattern<sup>1</sup>**

| CK_t, CK_c | CKE             | Sub-Loop                                                       | Cycle Number  | Command                                                                        | CS_n                                                           | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |                                                        |   |
|------------|-----------------|----------------------------------------------------------------|---------------|--------------------------------------------------------------------------------|----------------------------------------------------------------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|------|--------------------------------------------------------|---|
| toggling   | Static High     | 0                                                              | 0             | ACT                                                                            | 0                                                              | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | 0    | -                                                      |   |
|            |                 |                                                                | 1             | RDA                                                                            | 1                                                              | 0     | 0         | 0         | 0        |     | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | 0    | D0=00, D1=FF, D2=FF, D3=00, D4=FF, D5=00, D6=00, D7=FF |   |
|            |                 |                                                                | 2             | D                                                                              | 1                                                              | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 0       | 0        | 0           | 0        | 0      | 0      | 0      | 0    | 0                                                      | - |
|            |                 |                                                                | 3             | D#                                                                             | 1                                                              | 1     | 1         | 1         | 1        | 1   | 0      | 0       | 3       | 3        | 0           | 0        | 0      | 7      | F      | 0    | -                                                      |   |
|            |                 |                                                                | ...           | repeat pattern 2 ... 3 until nRRD – 1, if nRRD > 4, truncate if necessary      |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 1                                                              | nRRD          | ACT                                                                            | 0                                                              | 0     | 0         | 0         | 0        | 0   | 0      | 0       | 1       | 1        | 0           | 0        | 0      | 0      | 0      | 0    | 0                                                      | - |
|            |                 |                                                                | nRRD + 1      | RDA                                                                            | 0                                                              | 1     | 1         | 0         | 1        |     | 0      | 1       | 1       | 0        | 0           | 1        | 0      | 0      | 0      | 0    | D0=FF, D1=00, D2=00, D3=FF, D4=00, D5=FF, D6=FF, D7=00 |   |
|            |                 |                                                                | ...           | repeat pattern 2 ... 3 until 2*nRRD – 1, if nRRD > 4, truncate if necessary    |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 |                                                                | 2             | 2*nRRD                                                                         | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 2</b> instead |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 3                                                              | 3*nRRD        | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 3</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 4                                                              | 4*nRRD        | repeat pattern 2 ... 3 until nFAW – 1, if nFAW > 4*nRRD, truncate if necessary |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 |                                                                |               |                                                                                |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 5                                                              | nFAW          | repeat Sub-Loop 0, use <b>BG[1:0] = 0, BA[1:0] = 1</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 6                                                              | nFAW + nRRD   | repeat Sub-Loop 1, use <b>BG[1:0] = 1, BA[1:0] = 2</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 7                                                              | nFAW + 2*nRRD | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 3</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 8                                                              | nFAW + 3*nRRD | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 0</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 9                                                              | nFAW + 4*nRRD | repeat Sub-Loop 4                                                              |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 |                                                                |               |                                                                                |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 10                                                             | 2*nFAW        | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 0</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
|            |                 | 11                                                             | 2*nFAW + nRRD | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 1</b> instead                 |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
| 12         | 2*nFAW + 2*nRRD | repeat Sub-Loop 0, use <b>BG[1:0] = 2, BA[1:0] = 2</b> instead |               |                                                                                |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |
| 13         | 2*nFAW + 3*nRRD | repeat Sub-Loop 1, use <b>BG[1:0] = 3, BA[1:0] = 3</b> instead |               |                                                                                |                                                                |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |                                                        |   |

| CK_t, CK_c | CKE | Sub-Loop | Cycle Number    | Command                                                                     | CS_n | ACT_n | RAS_n/A16 | CAS_n/A15 | WE_n/A14 | ODT | C[2:0] | BG[1:0] | BA[1:0] | A12/BC_n | A[17,13,11] | A[10]/AP | A[9:7] | A[6:3] | A[2:0] | Data |
|------------|-----|----------|-----------------|-----------------------------------------------------------------------------|------|-------|-----------|-----------|----------|-----|--------|---------|---------|----------|-------------|----------|--------|--------|--------|------|
|            |     | 14       | 2*nFAW + 4*nRRD | repeat Sub-Loop 4                                                           |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     |          |                 |                                                                             |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 15       | 3*nFAW          | repeat Sub-Loop 0, use <b>BG[1:0] = 2</b> , <b>BA[1:0] = 1</b> instead      |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 16       | 3*nFAW + nRRD   | repeat Sub-Loop 1, use <b>BG[1:0] = 3</b> , <b>BA[1:0] = 2</b> instead      |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 17       | 3*nFAW + 2*nRRD | repeat Sub-Loop 0, use <b>BG[1:0] = 2</b> , <b>BA[1:0] = 3</b> instead      |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 18       | 3*nFAW + 3*nRRD | repeat Sub-Loop 1, use <b>BG[1:0] = 3</b> , <b>BA[1:0] = 0</b> instead      |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 19       | 3*nFAW + 4*nRRD | repeat Sub-Loop 4                                                           |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     |          |                 |                                                                             |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |
|            |     | 20       | 4*nFAW          | repeat pattern 2 ... 3 until nRC– 1, if nRC > 4*nFAW, truncate if necessary |      |       |           |           |          |     |        |         |         |          |             |          |        |        |        |      |

**Note:**

1. DQS\_t, DQS\_c are VDDQ.
2. C[2:0] are used only for 3DS device.
3. Burst Sequence driven on each DQ signal by Read Command. Outside burst operation, DQ signals are VDDQ.

## IDD Specifications

IDD and IPP values are for full operating range of voltage and temperature unless otherwise noted. IDD and IPP values are for full operating range of voltage and temperature unless otherwise noted.

### IDD and IDDQ Specification

| Speed Grade Bin |                      | Unit | Note |
|-----------------|----------------------|------|------|
| Symbol          | DDR4-3200 (22-22-22) |      |      |
| IDD0            | 31                   | mA   |      |
| IDD0A           | 33                   | mA   |      |
| IDD1            | 34                   | mA   |      |
| IDD1A           | 41                   | mA   |      |
| IDD2N           | 20                   | mA   |      |
| IDD2NA          | 22                   | mA   |      |
| IDD2NT          | 22                   | mA   |      |
| IDD2NL          | 17                   | mA   |      |
| IDD2NG          | 21                   | mA   |      |
| IDD2ND          | 19                   | mA   |      |
| IDD2N_par       | 21                   | mA   |      |
| IDD2P           | 13                   | mA   |      |
| IDD2Q           | 20                   | mA   |      |
| IDD3N           | 30                   | mA   |      |
| IDD3NA          | 32                   | mA   |      |
| IDD3P           | 21                   | mA   |      |
| IDD4R           | 114                  | mA   |      |
| IDD4RA          | 122                  | mA   |      |
| IDD4RB          | 116                  | mA   |      |
| IDD4W           | 106                  | mA   |      |
| IDD4WA          | 113                  | mA   |      |
| IDD4WB          | 107                  | mA   |      |
| IDD4WC          | 98                   | mA   |      |
| IDD4W_par       | 119                  | mA   |      |
| IDD5B           | 230                  | mA   |      |
| IDD5F2          | 162                  | mA   |      |
| IDD5F4          | 145                  | mA   |      |
| IDD7            | 158                  | mA   |      |
| IDD8            | 11                   | mA   |      |

**IPP Specification**

| Speed Grade Bin |                      | Unit | Note |
|-----------------|----------------------|------|------|
| Symbol          | DDR4-3200 (22-22-22) |      |      |
| IPP0            | 4                    | mA   |      |
| IPP1            | 4                    | mA   |      |
| IPP2N           | 3                    | mA   |      |
| IPP2P           | 3                    | mA   |      |
| IPP3N           | 4                    | mA   |      |
| IPP3P           | 4                    | mA   |      |
| IPP4R           | 4                    | mA   |      |
| IPP4W           | 4                    | mA   |      |
| IPP5B           | 25                   | mA   |      |
| IPP5F2          | 18                   | mA   |      |
| IPP5F4          | 17                   | mA   |      |
| IPP7            | 11                   | mA   |      |
| IPP8            | 3                    | mA   |      |

**IDD6 Specification**

| Symbol | Temperature Range | DDR4-3200 (22-22-22) | Unit | Note  |
|--------|-------------------|----------------------|------|-------|
| IDD6N  | 0 to 85°C         | 21                   | mA   | 2,3   |
|        | -40 to 85°C       | 21                   |      |       |
| IDD6E  | 0 to 95°C         | 32                   | mA   | 3,4,5 |
|        | -40 to 95°C       | 32                   |      |       |
| IDD6R  | 0 to 45°C         | 14                   | mA   | 3,5,7 |
|        | -40 to 45°C       | 14                   |      |       |
| IDD6A  | 0 to 85°C         | 20                   | mA   | 3,5,6 |
|        | -40 to 85°C       | 20                   |      |       |

**IPP6 Specification**

| Symbol | Temperature Range | DDR4-3200 (22-22-22) | Unit | Note  |
|--------|-------------------|----------------------|------|-------|
| IPP6N  | 0 to 85°C         | 6                    | mA   | 2,3   |
|        | -40 to 85°C       | 6                    |      |       |
| IPP6E  | 0 to 95°C         | 8                    | mA   | 3,4,5 |
|        | -40 to 95°C       | 8                    |      |       |

**Note:**

1. Max. values for IDD currents considering worst case conditions of process, temperature and voltage.
2. Applicable for MR2 settings A6=0 and A7=0.
3. Supplier data sheets include a max value for IDD6.
4. Applicable for MR2 settings A6=0 and A7=1. IDD6E is only specified for devices which support the Extended Temperature Range feature.
5. Refer to the supplier data sheet for the value specification method (e.g., max, typical) for IDD6E and IDD6A.
6. Applicable for MR2 settings A6=1 and A7=0. IDD6A is only specified for devices which support the Auto Self Refresh feature.
7. Applicable for MR2 settings MR2 [A7:A6 = 01]: Reduced Temperature range. IDD6R is verified by design and characterization, and may not be subject to production test

## Input/Output Capacitance

### Silicon pad I/O Capacitance

| Symbol                  | Parameter                                                            | DDR4-3200 |      | Unit | Note     |
|-------------------------|----------------------------------------------------------------------|-----------|------|------|----------|
|                         |                                                                      | Min.      | Max. |      |          |
| C <sub>IO</sub>         | Input/output capacitance                                             | 0.55      | 1.15 | pF   | 1,2,3    |
| C <sub>DIO</sub>        | Input/output capacitance delta                                       | -0.1      | 0.1  | pF   | 1,2,3,11 |
| C <sub>DDQS</sub>       | Input/output capacitance delta DQS <sub>t</sub> and DQS <sub>c</sub> | -         | 0.05 | pF   | 1,2,3,5  |
| C <sub>CK</sub>         | Input capacitance, CK <sub>t</sub> and CK <sub>c</sub>               | 0.2       | 0.7  | pF   | 1,3      |
| C <sub>DCK</sub>        | Input capacitance delta CK <sub>t</sub> and CK <sub>c</sub>          | -         | 0.05 | pF   | 1,3,4    |
| C <sub>I</sub>          | Input capacitance (CTRL, ADD, CMD pins only)                         | 0.2       | 0.55 | pF   | 1,3,6    |
| C <sub>DI_CTRL</sub>    | Input capacitance delta (All CTRL pins only)                         | -0.1      | 0.1  | pF   | 1,3,7,8  |
| C <sub>DI_ADD_CMD</sub> | Input capacitance delta (All ADD/CMD pins only)                      | -0.1      | 0.1  | pF   | 1,2,9,10 |
| C <sub>ALERT</sub>      | Input/output capacitance of ALERT                                    | 0.5       | 1.5  | pF   | 1,3      |
| C <sub>ZQ</sub>         | Input/output capacitance of ZQ                                       | -         | 2.3  | pF   | 1,3,12   |
| C <sub>TEN</sub>        | Input capacitance of TEN                                             | 0.2       | 2.3  | pF   | 1,3,13   |

#### Note:

1. This parameter is not subject to production test. It is verified by design and characterization. The silicon only capacitance is validated by de-embedding the package L & C parasitic. The capacitance is measured with VDD, VDDQ, VSS, VSSQ applied with all other signal pins floating. Measurement procedure tbd.
2. DQ, DM<sub>n</sub>, DQS<sub>t</sub>, DQS<sub>c</sub>. Although the DM pins have different functions, the loading matches DQ and DQS.
3. This parameter applies to monolithic devices only; stacked/dual-die devices are not covered here.
4. Absolute value CK<sub>t</sub>-CK<sub>c</sub>.
5. Absolute value of CIO(DQS<sub>t</sub>)-CIO(DQS<sub>c</sub>).
6. CI applies to ODT, CS<sub>n</sub>, CKE, A0-A17, BA0-BA1, BG0-BG1, RAS<sub>n</sub>/A16, CAS<sub>n</sub>/A15, WE<sub>n</sub>/A14, ACT<sub>n</sub> and PAR.
7. CDI CTRL applies to ODT, CS<sub>n</sub> and CKE.
8. CDI\_CTRL = CI(CTRL)-0.5\*(CI(CK<sub>t</sub>)+CI(CK<sub>c</sub>)).
9. CDI\_ADD\_CMD applies to, A0-A17, BA0-BA1, BG0-BG1, RAS<sub>n</sub>/A16, CAS<sub>n</sub>/A15, WE<sub>n</sub>/A14, ACT<sub>n</sub> and PAR.
10. CDI\_ADD\_CMD = CI(ADD\_CMD)-0.5\*(CI(CK<sub>t</sub>)+CI(CK<sub>c</sub>)).
11. CDIO = CIO(DQ,DM)-0.5\*(CIO(DQS<sub>t</sub>)+CIO(DQS<sub>c</sub>)).
12. Maximum external load capacitance on ZQ pin: tbd pF.
13. TEN pin may be DRAM internally pulled low through a weak pull-down resistor to VSS. In this case CTEN might not be valid and system shall verify TEN signal with Vendor specific information.

**DRAM package electrical specifications**

| Symbol                  | Parameter                     | DDR4-3200 |      | Unit | Note          |
|-------------------------|-------------------------------|-----------|------|------|---------------|
|                         |                               | Min.      | Max. |      |               |
| Z <sub>IO</sub>         | Input/output Zpkg             | 48        | 85   | Ω    | 1,2,4,5,10,11 |
| T <sub>dIO</sub>        | Input/output Pkg Delay        | 14        | 40   | ps   | 1,3,4,5,11    |
| L <sub>IO</sub>         | Input/Output Lpkg             | -         | 3.3  | nH   | 11,12         |
| C <sub>IO</sub>         | Input/Output Cpkg             | -         | 0.78 | pF   | 11,13         |
| Z <sub>IO DQS</sub>     | DQS_t, DQS_c Zpkg             | 48        | 85   | Ω    | 1,2,5,10,11   |
| T <sub>dIO DQS</sub>    | DQS_t, DQS_c Pkg Delay        | 14        | 40   | ps   | 1,3,5,10,11   |
| L <sub>IO DQS</sub>     | DQS Lpkg                      | -         | 3.3  | nH   | 11,12         |
| C <sub>IO DQS</sub>     | DQS Cpkg                      | -         | 0.78 | pF   | 11,13         |
| DZ <sub>DIO DQS</sub>   | Delta Zpkg DQS_t, DQS_c       | -         | 10   | Ω    | 1,2,5,7,10    |
| DT <sub>dDIO DQS</sub>  | Delta Delay DQS_t, DQS_c      | -         | 5    | ps   | 1,3,5,7,10    |
| Z <sub>I CTRL</sub>     | Input CTRL pins Zpkg          | 50        | 90   | Ω    | 1,2,5,9,10,11 |
| T <sub>dI CTRL</sub>    | Input CTRL pins Pkg Delay     | 14        | 40   | ps   | 1,3,5,9,10,11 |
| L <sub>I CTRL</sub>     | Input CTRL Lpkg               | -         | 3.4  | nH   | 11,12         |
| C <sub>I CTRL</sub>     | Input CTRL Cpkg               | -         | 0.7  | pF   | 11,13         |
| Z <sub>I ADD CMD</sub>  | Input- CMD ADD pins Zpkg      | 50        | 90   | Ω    | 1,2,5,8,10,11 |
| T <sub>dI ADD CMD</sub> | Input- CMD ADD pins Pkg Delay | 14        | 40   | ps   | 1,3,5,8,10,11 |
| L <sub>I ADD CMD</sub>  | Input CMD ADD Lpkg            | -         | 3.6  | nH   | 11,12         |
| C <sub>I ADD CMD</sub>  | Input CMD ADD Cpkg            | -         | 0.74 | pF   | 11,13         |
| Z <sub>CK</sub>         | CK_t & CK_c Zpkg              | 50        | 90   | Ω    | 1,2,5,10,11   |
| T <sub>dCK</sub>        | CK_t & CK_c Pkg Delay         | 14        | 42   | ps   | 1,3,5,10,11   |
| L <sub>I CLK</sub>      | Input CK Lpkg                 | -         | 3.4  | nH   | 11,12         |
| C <sub>I CLK</sub>      | Input CK Cpkg                 | -         | 0.7  | pF   | 11,13         |
| DZ <sub>dCK</sub>       | Delta Zpkg CK_t & CK_c        | -         | 10   | Ω    | 1,2,5,6,10    |
| DT <sub>dCK</sub>       | Delta Delay CK_t & CK_c       | -         | 5    | ps   | 1,3,5,6,10    |
| Z <sub>OZQ</sub>        | ZQ Zpkg                       | 40        | 100  | Ω    | 1,2,5,10,11   |
| T <sub>dO ZQ</sub>      | ZQ Delay                      | 20        | 90   | ps   | 1,3,5,10,11   |
| Z <sub>O ALERT</sub>    | ALERT Zpkg                    | 40        | 100  | Ω    | 1,2,5,10,11   |
| T <sub>dO ALERT</sub>   | ALERT Delay                   | 20        | 55   | ps   | 1,3,5,10,11   |



**Note:**

1. This parameter is not subject to production test. It is verified by design and characterization. The package parasitic( L & C) are validated using package only samples. The capacitance is measured with  $V_{DD}$ ,  $V_{DDQ}$ ,  $V_{SS}$ ,  $V_{SSQ}$  shorted with all other signal pins floating. The inductance is measured with  $V_{DD}$ ,  $V_{DDQ}$ ,  $V_{SS}$  and  $V_{SSQ}$  shorted and all other signal pins shorted at the die side(not pin). Measurement procedure tbd.
2. Package only impedance (Zpkg) is calculated based on the Lpkg and Cpkg total for a given pin where:
$$Z_{pkg}(\text{total per pin}) = \sqrt{L_{pkg} / C_{pkg}}$$
3. Package only delay(Tpkg) is calculated based on Lpkg and Cpkg total for a given pin where:
$$T_{dpkg}(\text{total per pin}) = \sqrt{L_{pkg} * C_{pkg}}$$
4. Z & Td IO applies to DQ, DM, TDQS\_T and TDQS\_C.
5. This parameter applies to monolithic devices only; stacked/dual-die devices are not covered here.
6. Absolute value of ZCK\_t-ZCK\_c for impedance(Z) or absolute value of TdCK\_t-TdCK\_c for delay(Td).
7. Absolute value of ZIO(DQS\_t)-ZIO(DQS\_c) for impedance(Z) or absolute value of TdIO(DQS\_t)-TdIO(DQS\_c) for delay(Td).
8. ZI & Td ADD CMD applies to A0-A13,A17, ACT\_n BA0-BA1, BG0-BG1, RAS\_n/A16 CAS\_n/A15, WE\_n/A14 and PAR.
9. ZI & Td CTRL applies to ODT, CS\_n and CKE.
10. This table applies to monolithic x8 devices.
11. Package implementations shall meet spec if the Zpkg and Pkg Delay fall within the ranges shown, and the maximum Lpkg and Cpkg do not exceed the maximum values shown.
12. It is assumed that Lpkg can be approximated as  $L_{pkg} = Z_o * T_d$ .
13. It is assumed that Cpkg can be approximated as  $C_{pkg} = T_d / Z_o$ .

## Electrical Characteristics & AC Timing

### Reference Load for AC Timing and Output Slew Rate

**Reference Load for AC Timing and Output Slew Rate** figure represents the effective reference load of 50 ohms used in defining the relevant AC timing parameters of the device as well as output slew rate measurements.

Ron nominal of DQ, DQS\_t and DQS\_c drivers uses 34 ohms to specify the relevant AC timing parameter values of the device.

The maximum DC High level of Output signal =  $1.0 * VDDQ$ ,

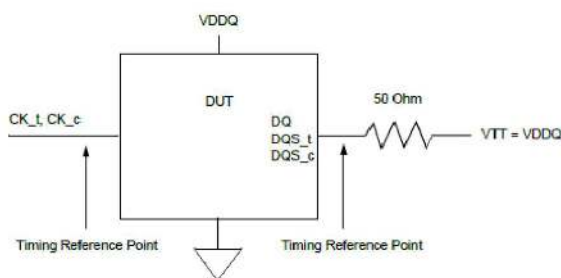
The minimum DC Low level of Output signal =  $\{ 34 / ( 34 + 50 ) \} * VDDQ = 0.4 * VDDQ$

The nominal reference level of an Output signal can be approximated by the following:

The center of maximum DC High and minimum DC Low =  $\{ ( 1 + 0.4 ) / 2 \} * VDDQ = 0.7 * VDDQ$

The actual reference level of Output signal might vary with driver Ron and reference load tolerances. Thus, the actual reference level or midpoint of an output signal is at the widest part of the output signal's eye. Prior to measuring AC parameters, the reference level of the verification tool should be set to an appropriate level.

It is not intended as a precise representation of any particular system environment or a depiction of the actual load presented by a production tester. System designers should use IBIS or other simulation tools to correlate the timing reference load to a system environment. Manufacturers correlate to their production test conditions, generally one or more coaxial transmission lines terminated at the tester electronics.



**Reference Load for AC Timing and Output Slew Rate**

### tREFI

Average periodic Refresh interval (tREFI) of DDR4 SDRAM is defined as shown in the table.

#### tREFI by device density

| Parameter                         | Symbol |                                                                    | 8Gb | Unit |
|-----------------------------------|--------|--------------------------------------------------------------------|-----|------|
| Average periodic refresh interval | tREFI  | $0^{\circ}\text{C} \leq T_{\text{CASE}} \leq 85^{\circ}\text{C}$   | 7.8 | us   |
|                                   |        | $-40^{\circ}\text{C} \leq T_{\text{CASE}} \leq 85^{\circ}\text{C}$ |     |      |
|                                   |        | $85^{\circ}\text{C} < T_{\text{CASE}} \leq 95^{\circ}\text{C}$     | 3.9 | us   |

## Clock Specification

The jitter specified is a random jitter meeting a Gaussian distribution. Input clocks violating the min/max values may result in malfunction of the DDR4 SDRAM device.

### Definition for tCK(abs)

tCK(abs) is defined as the absolute clock period, as measured from one rising edge to the next consecutive rising edge. tCK(abs) is not subject to production test.

### Definition for tCK(avg)

tCK(avg) is calculated as the average clock period across any consecutive 200 cycle window, where each clock period is calculated from rising edge to rising edge.

$$tCK(avg) = \left( \sum_{j=1}^N tCK_j \right) / N \quad N = 200$$

### Definition for tCH(avg) and tCL(avg)

tCH(avg) is defined as the average high pulse width, as calculated across any consecutive 200 high pulses.

$$tCH(avg) = \left( \sum_{j=1}^N tCH_j \right) / \{N \times tCK(avg)\} \quad N = 200$$

tCL(avg) is defined as the average low pulse width, as calculated across any consecutive 200 low pulses.

$$tCL(avg) = \left( \sum_{j=1}^N tCL_j \right) / \{N \times tCK(avg)\} \quad N = 200$$

### Definition for tERR(nper)

tERR is defined as the cumulative error across n consecutive cycles of n x tCK(avg). tERR is not subject to production test.

### Timing Parameters by Speed Grade

| Speed                                                  |                | DDR4-3200                      |                             | Unit     | Note  |
|--------------------------------------------------------|----------------|--------------------------------|-----------------------------|----------|-------|
| Parameter                                              | Symbol         | Min                            | Max                         |          |       |
| Clock Timing                                           |                |                                |                             |          |       |
| Minimum Clock Cycle Time (DLL off mode)                | tCK (DLL_OFF)  | 8                              | 20                          | ns       |       |
| Average Clock Period                                   | tCK(avg)       | 0.625                          | <0.682                      | ns       | 35,36 |
| Average high pulse width                               | tCH(avg)       | 0.48                           | 0.52                        | tCK(avg) |       |
| Average low pulse width                                | tCL(avg)       | 0.48                           | 0.52                        | tCK(avg) |       |
| Absolute Clock Period                                  | tCK(abs)       | tCK(avg)min + tJIT(per)min_tot | tCK(avg)m + tJIT(per)ax_tot | tCK(avg) |       |
| Absolute clock HIGH pulse width                        | tCH(abs)       | 0.45                           | -                           | tCK(avg) | 23    |
| Absolute clock LOW pulse width                         | tCL(abs)       | 0.45                           | -                           | tCK(avg) | 24    |
| Clock Period Jitter - total                            | JIT(per)_tot   | -32                            | 32                          | ps       | 25    |
| Clock Period Jitter - deterministic                    | JIT(per)_dj    | -16                            | 16                          | ps       | 26    |
| Clock Period Jitter during DLL locking period          | tJIT(per, lck) | -25                            | 25                          | ps       |       |
| Cycle to Cycle Period Jitter                           | tJIT(cc)       | -                              | 62                          | ps       |       |
| Cycle to Cycle Period Jitter during DLL locking period | tJIT(cc, lck)  | -                              | 50                          | ps       |       |
| Cumulative error across 2 cycles                       | tERR(2per)     | -46                            | 46                          | ps       |       |
| Cumulative error across 3 cycles                       | tERR(3per)     | -55                            | 55                          | ps       |       |
| Cumulative error across 4 cycles                       | tERR(4per)     | -61                            | 61                          | ps       |       |
| Cumulative error across 5 cycles                       | tERR(5per)     | -65                            | 65                          | ps       |       |
| Cumulative error across 6 cycles                       | tERR(6per)     | -69                            | 69                          | ps       |       |
| Cumulative error across 7 cycles                       | tERR(7per)     | -73                            | 73                          | ps       |       |
| Cumulative error across 8 cycles                       | tERR(8per)     | -76                            | 76                          | ps       |       |
| Cumulative error across 9 cycles                       | tERR(9per)     | -78                            | 78                          | ps       |       |
| Cumulative error across 10 cycles                      | tERR(10per)    | -80                            | 80                          | ps       |       |
| Cumulative error across 11 cycles                      | tERR(11per)    | -83                            | 83                          | ps       |       |
| Cumulative error across 12 cycles                      | tERR(12per)    | -84                            | 84                          | ps       |       |

| Speed                                                                                            |             | DDR4-3200                                        |                                                  | Unit | Note     |
|--------------------------------------------------------------------------------------------------|-------------|--------------------------------------------------|--------------------------------------------------|------|----------|
| Parameter                                                                                        | Symbol      | Min                                              | Max                                              |      |          |
| Cumulative error across 13 cycles                                                                | tERR(13per) | -86                                              | 86                                               | ps   |          |
| Cumulative error across 14 cycles                                                                | tERR(14per) | -87                                              | 87                                               | ps   |          |
| Cumulative error across 15 cycles                                                                | tERR(15per) | -89                                              | 89                                               | ps   |          |
| Cumulative error across 16 cycles                                                                | tERR(16per) | -90                                              | 90                                               | ps   |          |
| Cumulative error across 17 cycles                                                                | tERR(17per) | -92                                              | 92                                               | ps   |          |
| Cumulative error across 18 cycles                                                                | tERR(18per) | -93                                              | 93                                               | ps   |          |
| Cumulative error across n = 13, 14 . . . 49, 50 cycles                                           | tERR(nper)  | $((1 + 0.68\ln(n)) * t_{JIT(per)}_{total\ min})$ | $((1 + 0.68\ln(n)) * t_{JIT(per)}_{total\ max})$ | ps   |          |
| Command and Address setup time to CK_t, CK_c referenced to Vih(ac) / Vil(ac) levels              | tIS(base)   | 40                                               | -                                                | ps   |          |
| Command and Address setup time to CK_t, CK_c referenced to Vref levels                           | tIS(Vref)   | 130                                              | -                                                | ps   |          |
| Command and Address hold time to CK_t, CK_c referenced to Vih(dc) / Vil(dc) levels               | tIH(base)   | 65                                               | -                                                | ps   |          |
| Command and Address hold time to CK_t, CK_c referenced to Vref levels                            | tIH(Vref)   | 130                                              | -                                                | ps   |          |
| Control and Address Input pulse width for each input                                             | tIPW        | 340                                              | -                                                | ps   |          |
| <b>Command and Address Timing</b>                                                                |             |                                                  |                                                  |      |          |
| CAS_n to CAS_n command delay for same bank group                                                 | tCCD_L      | max(5nCK, 5ns)                                   | -                                                | nCK  | 34       |
| CAS_n to CAS_n command delay for different bank group                                            | tCCD_S      | 4                                                | -                                                | nCK  | 34       |
| ACTIVATE to ACTIVATE Command delay to different bank group for 1KB page size                     | tRRD_S(1K)  | max(4nCK, 2.5ns)                                 | -                                                | nCK  | 34       |
| ACTIVATE to ACTIVATE Command delay to same bank group for 1KB page size                          | tRRD_L(1K)  | max(4nCK, 4.9ns)                                 | -                                                | nCK  | 34       |
| Four activate window for 1KB page size                                                           | tFAW_1K     | max(20nCK, 21ns)                                 | -                                                | ns   | 34       |
| Delay from start of internal write transaction to internal read command for different bank group | tWTR_S      | max(2nCK, 2.5ns)                                 | -                                                | ns   | 1,2,e,34 |

| Speed                                                                                                                          |               | DDR4-3200                                |      | Unit       | Note        |
|--------------------------------------------------------------------------------------------------------------------------------|---------------|------------------------------------------|------|------------|-------------|
| Parameter                                                                                                                      | Symbol        | Min                                      | Max  |            |             |
| Delay from start of internal write transaction to internal read command for same bank group                                    | tWTR_L        | max(4nCK, 7.5ns)                         | -    |            | 1,34        |
| Internal READ Command to PRECHARGE Command delay                                                                               | tRTP          | max(4nCK, 7.5ns)                         | -    |            | 34          |
| WRITE recovery time                                                                                                            | tWR           | 15                                       | -    | ns         | 1           |
| Write recovery time when CRC and DM are enabled                                                                                | tWR_CRC_DM    | tWR + max(5nCK, 3.75ns)                  | -    | ns         | 1,28        |
| Delay from start of internal write transaction to internal read command for different bank groups with both CRC and DM enabled | tWTR_S_CRC_DM | tWTR_S + max(5nCK, 3.75ns)               | -    | ns         | 2, 29,34    |
| Delay from start of internal write transaction to internal read command for same bank group with both CRC and DM enabled       | tWTR_L_CRC_DM | tWTR_L + max(5nCK, 3.75ns)               | -    | ns         | 3,30,34     |
| DLL locking time                                                                                                               | tDLLK         | 1024                                     | -    | nCK        |             |
| Mode Register Set command cycle time                                                                                           | tMRD          | 8                                        | -    | nCK        |             |
| Mode Register Set command update delay                                                                                         | tMOD          | max(24nCK, 15ns)                         | -    | nCK        | 50          |
| Multi-Purpose Register Recovery Time                                                                                           | tMPRR         | 1                                        | -    | nCK        | 33          |
| Multi Purpose Register Write Recovery Time                                                                                     | tWR_MPR       | tMOD (min) + AL + PL                     | -    | nCK        |             |
| Auto precharge write recovery + precharge time                                                                                 | tDAL(min)     | Programmed WR + roundup (tRP / tCK(avg)) |      | nCK        | 52          |
| DQ0 or DQL0 driven to 0 set-up time to first DQS rising edge                                                                   | tPDA_S        | 0.5                                      | -    | UI         | 45,47       |
| DQ0 or DQL0 driven to 0 hold time from last DQS falling edge                                                                   | tPDA_H        | 0.5                                      | -    | UI         | 46,47       |
| <b>CS_n to Command Address Latency</b>                                                                                         |               |                                          |      |            |             |
| CS_n to Command Address Latency                                                                                                | tCAL          | max(3 nCK, 3.748 ns)                     | -    | nCK        |             |
| Mode Register Set command cycle time in CAL mode                                                                               | tMRD_tCAL     | tMOD + tCAL                              | -    | nCK        |             |
| Mode Register Set update delay in CAL mode                                                                                     | tMOD_tCAL     | tMOD + tCAL                              | -    | nCK        |             |
| <b>DRAM Data Timing</b>                                                                                                        |               |                                          |      |            |             |
| DQS_t, DQS_c to DQ skew, per group, per access                                                                                 | tDQSQ         | -                                        | 0.20 | tCK(avg)/2 | 13,18,39,49 |

| Speed                                                                            |          | DDR4-3200 |         | Unit       | Note           |
|----------------------------------------------------------------------------------|----------|-----------|---------|------------|----------------|
| Parameter                                                                        | Symbol   | Min       | Max     |            |                |
| DQ output hold time per group, per access from DQS_t, DQS_c                      | tQH      | 0.70      | -       | tCK(avg)/2 | 13,17,18,39,49 |
| Data Valid Window per device per UI: (tQH - tDQSQ) of each UI on a given DRAM    | tDVWd    | 0.64      | -       | UI         | 17,18,39,49    |
| Data Valid Window per pin per UI: (tQH - tDQSQ) each UI on a pin of a given DRAM | tDVWp    | 0.72      | -       | UI         | 17,18,39,49    |
| DQ low impedance time from CK_t, CK_c                                            | tLZ(DQ)  | -250      | 160     | ps         | 39             |
| DQ high impedance time from CK_t, CK_c                                           | tHZ(DQ)  | -         | 160     | ps         | 39             |
| <b>Data Strobe Timing</b>                                                        |          |           |         |            |                |
| DQS_t, DQS_c differential READ Preamble (1 clock preamble)                       | tRPRE    | 0.9       | Note 44 | tCK        | 39,40          |
| DQS_t, DQS_c differential READ Preamble (2 clock preamble)                       | tRPRE2   | 1.8       | Note 44 | tCK        | 39,41          |
| DQS_t, DQS_c differential READ Postamble                                         | tRPST    | 0.33      | Note 45 | tCK        | 39             |
| DQS_t, DQS_c differential output high time                                       | tQSH     | 0.4       | -       | tCK        | 21,39          |
| DQS_t, DQS_c differential output low time                                        | tQSL     | 0.4       | -       | tCK        | 20,39          |
| DQS_t, DQS_c differential WRITE Preamble (1 clock preamble)                      | tWPRE    | 0.9       | -       | tCK        | 42             |
| DQS_t, DQS_c differential WRITE Preamble (2 clock preamble)                      | tWPRE2   | 1.8       | -       | tCK        | 43             |
| DQS_t, DQS_c differential WRITE Postamble                                        | tWPST    | 0.33      | -       | tCK        |                |
| DQS_t, DQS_c low-impedance time Referenced from RL-1)                            | tLZ(DQS) | -250      | 160     | ps         | 39             |
| DQS_t, DQS_c high-impedance time (Referenced from RL+BL/2)                       | tHZ(DQS) | -         | 160     | ps         | 39             |
| DQS_t, DQS_c differential input low pulse width                                  | tDQSL    | 0.46      | 0.54    | tCK        |                |
| DQS_t, DQS_c differential input high pulse width                                 | tDQSH    | 0.46      | 0.54    | tCK        |                |
| DQS_t, DQS_c rising edge to CK_t, CK_c rising edge (1 clock preamble)            | tDQSS    | -0.27     | 0.27    | tCK        | 42             |

| Speed                                                                                   |                | DDR4-3200                   |      | Unit | Note     |
|-----------------------------------------------------------------------------------------|----------------|-----------------------------|------|------|----------|
| Parameter                                                                               | Symbol         | Min                         | Max  |      |          |
| DQS_t, DQS_c rising edge to CK_t, CK_c rising edge (2 clock preamble)                   | tDQSS2         | -0.50                       | 0.50 | tCK  | 43       |
| DQS_t, DQS_c falling edge setup time to CK_t, CK_c rising edge                          | tDSS           | 0.18                        | -    | tCK  |          |
| DQS_t, DQS_c falling edge hold time from CK_t, CK_c rising edge                         | tDSH           | 0.18                        | -    | tCK  |          |
| DQS_t, DQS_c rising edge output timing location from rising CK_t, CK_c with DLL On mode | tDQSCK(DLL On) | -160                        | 160  | ps   | 37,38,39 |
| DQS_t, DQS_c rising edge output variance window per DRAM                                | tDQSKI(DLL On) | -                           | 260  | ps   | 37,38,39 |
| <b>MPSM Timing</b>                                                                      |                |                             |      |      |          |
| Command path disable delay upon MPSM entry                                              | tMPED          | tMOD(min) + tCPDED(min)     | -    |      |          |
| Valid clock requirement after MPSM entry                                                | tCKMPE         | tMOD(min) + tCPDED(min)     | -    |      |          |
| Valid clock requirement before MPSM exit                                                | tCKMPX         | tCKSRX(min)                 | -    |      |          |
| Exit MPSM to commands not requiring a locked DLL                                        | tXMP           | tXS(min)                    | -    |      |          |
| Exit MPSM to commands requiring a locked DLL                                            | tXMPDLL        | tXMP(min) + tXSDLL(min)     | -    |      |          |
| CS setup time to CKE                                                                    | tMPX_S         | tISmin + tIHmin             | -    |      |          |
| <b>Calibration Timing</b>                                                               |                |                             |      |      |          |
| Power-up and RESET calibration time                                                     | tZQinit        | 1024                        | -    | nCK  |          |
| Normal operation Full calibration time                                                  | tZQoper        | 512                         | -    | nCK  |          |
| Normal operation Short calibration time                                                 | tZQCS          | 128                         | -    | nCK  |          |
| <b>Reset/Self Refresh Timing</b>                                                        |                |                             |      |      |          |
| Exit Reset from CKE HIGH to a valid command                                             | tXPR           | max(5nCK, tRFC(min) + 10ns) | -    | nCK  |          |
| Exit Self Refresh to commands not requiring a locked DLL                                | tXS            | tRFC(min) + 10ns            | -    | nCK  |          |
| SRX to commands not requiring a locked DLL in Self Refresh ABORT                        | tXS_ABORT(min) | tRFC4(min) + 10ns           | -    | nCK  |          |
| Exit Self Refresh to ZQCL, ZQCS and MRS (CL, CWL, WR, RTP and Gear Down)                | tXS_FAST(min)  | tRFC4(min) + 10ns           | -    | nCK  |          |



| Speed                                                                                                                              |             | DDR4-3200               |         | Unit | Note  |
|------------------------------------------------------------------------------------------------------------------------------------|-------------|-------------------------|---------|------|-------|
| Parameter                                                                                                                          | Symbol      | Min                     | Max     |      |       |
| Exit Self Refresh to commands requiring a locked DLL                                                                               | tXSDLL      | tDLLK(min)              | -       | nCK  |       |
| Minimum CKE low width for Self refresh entry to exit timing                                                                        | tCKESR      | tCKE(min) + 1nCK        | -       | nCK  |       |
| Minimum CKE low width for Self refresh entry to exit timing with CA Parity enabled                                                 | tCKESR_PAR  | tCKE(min) + 1nCK + PL   | -       | nCK  |       |
| Valid Clock Requirement after Self Refresh Entry (SRE) or Power-Down Entry (PDE)                                                   | tCKSRE      | max(5nCK, 10ns)         | -       | nCK  |       |
| Valid Clock Requirement after Self Refresh Entry (SRE) or Power-Down when CA Parity is enabled                                     | tCKSRE_PAR  | max(5nCK, 10ns) + PL    | -       | nCK  |       |
| Valid Clock Requirement before Self Refresh Exit (SRX) or Power-Down Exit (PDX) or Reset Exit                                      | tCKSRX      | max(5nCK, 10ns)         | -       | nCK  |       |
| <b>Power Down Timing</b>                                                                                                           |             |                         |         |      |       |
| Exit Power Down with DLL on to any valid command; Exit Precharge Power Down with DLL frozen to commands not requiring a locked DLL | tXP         | max(4nCK, 6ns)          | -       | nCK  |       |
| CKE minimum pulse width                                                                                                            | tCKE        | max (3nCK, 5ns)         | -       | nCK  | 31,32 |
| Command pass disable delay                                                                                                         | tCPDED      | 4                       | -       | nCK  |       |
| Power Down Entry to Exit Timing                                                                                                    | tPD         | tCKE(min)               | 9*tREFI | nCK  |       |
| Timing of ACT command to Power Down entry                                                                                          | tACTPDEN    | 2                       | -       | nCK  | 7     |
| Timing of PRE or PREA command to Power Down entry                                                                                  | tPRPDEN     | 2                       | -       | nCK  | 7     |
| Timing of RD/RDA command to Power Down entry                                                                                       | tRDPDEN     | RL + 4 + 1              | -       | nCK  |       |
| Timing of WR command to Power Down entry (BL8OTF, BL8MRS, BC4OTF)                                                                  | tWRPDEN     | WL + 4 + (tWR/tCK(avg)) | -       | nCK  | 4     |
| Timing of WRA command to Power Down entry (BL8OTF, BL8MRS, BC4OTF)                                                                 | tWRAPDEN    | WL + 4 + WR + 1         | -       | nCK  | 5     |
| Timing of WR command to Power Down entry (BC4MRS)                                                                                  | tWRPBC4DEN  | WL + 2 + (tWR/tCK(avg)) | -       | nCK  | 4     |
| Timing of WRA command to Power Down entry (BC4MRS)                                                                                 | tWRAPBC4DEN | WL + 2 + WR + 1         | -       | nCK  | 5     |
| Timing of REF command to Power Down entry                                                                                          | tREFPDEN    | 2                       | -       | nCK  | 7     |

| Speed                                                                                                           |                | DDR4-3200        |          | Unit     | Note |
|-----------------------------------------------------------------------------------------------------------------|----------------|------------------|----------|----------|------|
| Parameter                                                                                                       | Symbol         | Min              | Max      |          |      |
| Timing of MRS command to Power Down entry                                                                       | tMRSPDEN       | tMOD(min)        | -        | nCK      |      |
| PDA Timing                                                                                                      |                |                  |          |          |      |
| Mode Register Set command cycle time in PDA mode                                                                | tMRD_PDA       | max(16nCK, 10ns) | -        | nCK      |      |
| Mode Register Set command update delay in PDA mode                                                              | tMOD_PDA       | tMOD             |          | nCK      |      |
| ODT Timing                                                                                                      |                |                  |          |          |      |
| Asynchronous RTT turn-on delay (Power-Down with DLL frozen)                                                     | tAONAS         | 1.0              | 9.0      | ns       |      |
| Asynchronous RTT turn-off delay (Power-Down with DLL frozen)                                                    | tAOFAS         | 1.0              | 9.0      | ns       |      |
| RTT dynamic change skew                                                                                         | tADC           | 0.26             | 0.74     | tCK(avg) |      |
| Write Leveling Timing                                                                                           |                |                  |          |          |      |
| First DQS_ t/DQS_ n rising edge after write leveling mode is programmed                                         | tWLMRD         | 40               | -        | nCK      | 12   |
| DQS_ t/DQS_ n delay after write leveling mode is programmed                                                     | tWLDQSEN       | 25               | -        | nCK      | 12   |
| Write leveling setup time from rising CK_ t, CK_ c crossing to rising DQS_ t/ DQS_ n crossing                   | tWLS           | 0.13             | -        | tCK(avg) |      |
| Write leveling hold time from rising DQS_ t/DQS_ n crossing to rising CK_ t, CK_ crossing                       | tWLH           | 0.13             | -        | tCK(avg) |      |
| Write leveling output delay                                                                                     | tWLO           | 0                | 9.5      | ns       |      |
| Write leveling output error                                                                                     | tWLOE          | 0                | 2        | ns       |      |
| CA Parity Timing                                                                                                |                |                  |          |          |      |
| Commands not guaranteed to be executed during this time                                                         | tPAR_UNKNOWN   | -                | PL       | nCK      |      |
| Delay from errant command to ALERT_ n assertion                                                                 | tPAR_ALERT_ON  | -                | PL + 6ns | nCK      |      |
| Pulse width of ALERT_ n signal when asserted                                                                    | tPAR_ALERT_PW  | 96               | 192      | nCK      |      |
| Time from when Alert is asserted till controller must start providing DES commands in Persistent CA parity mode | tPAR_ALERT_RSP | -                | 85       | nCK      |      |
| Parity Latency                                                                                                  | PL             | 6                | -        | nCK      |      |
| CRC Error Reporting                                                                                             |                |                  |          |          |      |
| CRC error to ALERT_ n latency                                                                                   | tCRC_ALERT     | 3                | 13       | ns       |      |

| Speed                                                       |              | DDR4-3200   |     | Unit | Note |
|-------------------------------------------------------------|--------------|-------------|-----|------|------|
| Parameter                                                   | Symbol       | Min         | Max |      |      |
| CRC ALERT_n pulse width                                     | CRC_ALERT_PW | 6           | 10  | nCK  |      |
| <b>Geardown Timing</b>                                      |              |             |     |      |      |
| Exit RESET from CKE HIGH to a valid MRS geardown (T2/Reset) | tXPR_GEAR    | tXPR        | -   |      |      |
| CKE High Assert to Gear Down Enable time(T2/CKE)            | tXS_GEAR     | tXS         | -   |      |      |
| MRS command to Sync pulse time(T3)                          | tSYNC_GEAR   | tMOD + 4nCK | -   |      | 27   |
| Sync pulse to First valid command(T4)                       | tCMD_GEAR    | tMOD        | -   |      | 27   |
| Geardown setup time                                         | tGEAR_setup  | 2           | -   | nCK  |      |
| Geardown hold time                                          | tGEAR_hold   | 2           | -   | nCK  |      |
| <b>tREFI</b>                                                |              |             |     |      |      |
| tRFC1 (min)                                                 | 8Gb          | 350         | -   | ns   | 34   |
| tRFC2 (min)                                                 | 8Gb          | 260         | -   | ns   | 34   |
| tRFC4 (min)                                                 | 8Gb          | 160         | -   | ns   | 34   |

**Note:**

- Start of internal write transaction is defined as follows:  
For BL8 (Fixed by MRS and on-the-fly) : Rising clock edge 4 clock cycles after WL. For BC4 (on-the-fly) : Rising clock edge 4 clock cycles after WL.  
For BC4 (fixed by MRS) : Rising clock edge 2 clock cycles after WL.
- A separate timing parameter will cover the delay from write to read when CRC and DM are simultaneously enabled.
- Commands requiring a locked DLL are: READ (and RAP) and synchronous ODT commands.
- tWR is defined in ns, for calculation of tWRPDEN it is necessary to round up tWR/tCK following rounding algorithm defined.
- WR in clock cycles as programmed in MR0.
- tREFI depends on T<sub>OPER</sub>.
- CKE is allowed to be registered low while operations such as row activation, precharge, autoprecharge or refresh are in progress, but power- down IDD spec will not be applied until finishing those operations.
- For these parameters, the DDR4 SDRAM device supports tnPARAM[nCK]=RU{tPARAM[ns]/tCK(avg)[ns]}, which is in clock cycles assuming all input clock jitter specifications are satisfied.
- When CRC and DM are both enabled, tWR\_CRC\_DM is used in place of tWR.
- When CRC and DM are both enabled tWTR\_S\_CRC\_DM is used in place of tWTR\_S.
- When CRC and DM are both enabled tWTR\_L\_CRC\_DM is used in place of tWTR\_L.
- The max values are system dependent.
- DQ to DQS total timing per group where the total includes the sum of deterministic and random timing terms for a specified BER. BER spec and measurement method are tbd.
- The deterministic component of the total timing. Measurement method tbd.
- DQ to DQ static offset relative to strobe per group. Measurement method tbd.
- This parameter will be characterized and guaranteed by design.
- When the device is operated with the input clock jitter, this parameter needs to be derated by the actual tjit(per)\_total of the input clock. (output deratings are relative to the SDRAM input clock). Example tbd.
- DRAM DBI mode is off.
- DRAM DBI mode is enabled. Applicable to x8 and x16 DRAM only.
- tQSL describes the instantaneous differential output low pulse width on DQS\_t - DQS\_c, as measured from on falling edge to the next consecutive rising edge.
- tQSH describes the instantaneous differential output high pulse width on DQS\_t - DQS\_c, as measured from on falling edge to the next consecutive rising edge.

22. There is no maximum cycle time limit besides the need to satisfy the refresh interval tREFI.
23. tCH(abs) is the absolute instantaneous clock high pulse width, as measured from one rising edge to the following falling edge.
24. tCL(abs) is the absolute instantaneous clock low pulse width, as measured from one falling edge to the following rising edge.
25. Total jitter includes the sum of deterministic and random jitter terms for a specified BER. BER target and measurement method are tbd.
26. The deterministic jitter component out of the total jitter. This parameter is characterized and guaranteed by design.
27. This parameter has to be even number of clocks
28. When CRC and DM are both enabled, tWR\_CRC\_DM is used in place of tWR.
29. When CRC and DM are both enabled tWTR\_S\_CRC\_DM is used in place of tWTR\_S.
30. When CRC and DM are both enabled tWTR\_L\_CRC\_DM is used in place of tWTR\_L.
31. After CKE is registered LOW, CKE signal level shall be maintained below VILDC for tCKE specification ( Low pulse width ).
32. After CKE is registered HIGH, CKE signal level shall be maintained above VIHDC for tCKE specification ( HIGH pulse width ).
33. Defined between end of MPR read burst and MRS which reloads MPR or disables MPR function.
34. Parameters apply from tCK(avg)min to tCK(avg)max at all standard JEDEC clock period values as stated in the Speed Bin Tables.
35. This parameter must keep consistency with Speed-Bin Tables.
36. DDR4-1600 AC timing apply if DRAM operates at lower than 1600 MT/s data rate.  $UI = tCK(avg).min/2$
37. applied when DRAM is in DLL ON mode.
38. Assume no jitter on input clock signals to the DRAM.
39. Value is only valid for RONNOM = 34 ohms.
40. 1tCK toggle mode with setting MR4:A11 to 0.
41. 2tCK toggle mode with setting MR4:A11 to 1, which is valid for DDR4-2400/2666 speed grade.
42. 1tCK mode with setting MR4:A12 to 0.
43. 2tCK mode with setting MR4:A12 to 1, which is valid for DDR4-2400/2666 speed grade.
44. The maximum read preamble is bounded by tLZ(DQS)min on the left side and tDQSCK(max) on the right side. See --- "Clock to Data Strobe Relationship" figure. Boundary of DQS Low-Z occur one cycle earlier in 2tCK toggle mode which is illustrated in Section ----- "Read Preamble".
45. DQ falling signal middle-point of transferring from High to Low to first rising edge of DQS diff-signal cross-point.
46. last falling edge of DQS diff-signal cross-point to DQ rising signal middle-point of transferring from Low to High.
47. VrefDQ value must be set to either its midpoint or Vcent\_DQ(midpoint) in order to capture DQ0 or DQL0 low level for entering PDA mode.
48. The maximum read postamble is bound by tDQSCK(min) plus tQSH(min) on the left side and tHZ(DQS)max on the right side. See "Clock to Data Strobe Relationship" figure.
49. Reference level of DQ output signal is specified with a midpoint as a widest part of Output signal eye which should be approximately  $0.7 * VDDQ$  as a center level of the static single-ended output peak-to-peak swing with a driver impedance of 34 ohms and an effective test load of 50 ohms to  $V_{TT} = VDDQ$ .
50. For MR7 commands, the minimum delay to a subsequent non-MRS command is 5nCK.
51. Optional' settings allow certain devices in the industry to support this setting, however, it is not a mandatory feature. tRFC2 and tRFC4 needs to be set corresponding to each setting's value (default / optional-1 / optional-2) accordingly. Refer to supplier's data sheet and/or the DIMM SPD information if and how this setting is supported.
52. DALmin is required to refer to the rounding algorithm specified.

## Rounding Algorithms

Software algorithms for calculation of timing parameters are subject to rounding errors from many sources. For example, a system may use a memory clock with a nominal frequency of 933.33... MHz, or a clock period of 1.0714... ns. Similarly, a system with a memory clock frequency of 1066.66... MHz yields mathematically a clock period of 0.9375... ns. In most cases, it is impossible to express all digits after the decimal point exactly, and rounding must be done because the DDR4 SDRAM specification establishes a minimum granularity for timing parameters of 1 ps.

Rules for rounding must be defined to allow optimization of device performance without violating device parameters. These algorithms rely on results that are within correction factors on device testing and specification to avoid losing performance due to rounding errors.

These rules are:

- Clock periods such as tCKAVGmin are defined to 1 ps of accuracy; for example, 0.9375... ns is defined as 937 ps and 1.0714... ns is defined as 1071 ps.
- Using real math, parameters like tAmin, tRCDmin, etc. which are programmed in systems in numbers of clocks (nCK) but expressed in units of time (in ns) are divided by the clock period (in ns) yielding a unitless ratio, a correction factor of 2.5% is subtracted, then the result is set to the next higher integer number of clocks:

$$nCK = \text{ceiling} [ (\text{parameter\_in\_ns} / \text{application\_tCK\_in\_ns}) - 0.025 ]$$

- Alternatively, programmers may prefer to use integer math instead of real math by expressing timing in ps, scaling the desired parameter value by 1000, dividing by the application clock period, adding an inverse correction factor of 97.4%, dividing the result by 1000, then truncating down to the next lower integer value:

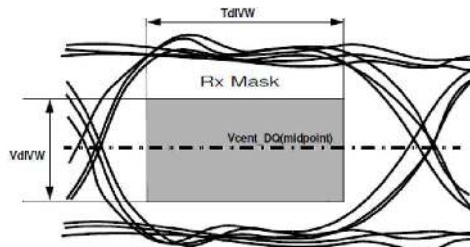
$$nCK = \text{truncate} [ \{ (\text{parameter\_in\_ps} \times 1000) / (\text{application\_tCK\_in\_ps}) + 974 \} / 1000 ]$$

- Either algorithm yields identical results. In case of conflict between results, the preferred algorithm is the integer math algorithm.
- This algorithm applies to all timing parameters documented in a Serial Presence Detect (SPD) when converting from ns to nCK. Other timing parameters may use a simpler algorithm,

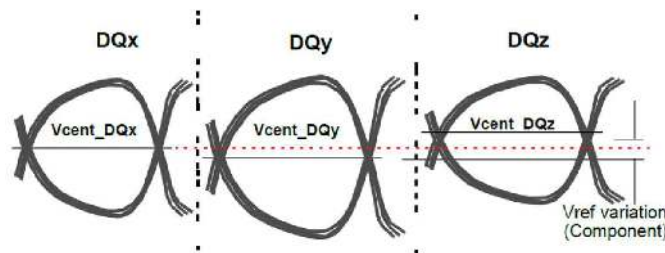
$$nCK = \text{ceiling} (\text{parameter\_in\_ns} \div \text{application\_tCK\_in\_ns}).$$

## The DQ input receiver compliance mask for voltage and timing

The DQ input receiver compliance mask for voltage and timing is shown in the figure below. The receiver mask (Rx Mask) defines area the input signal must not encroach in order for the DRAM input receiver to be expected to be able to successfully capture a valid input signal with BER of 1e-16; any input signal encroaching within the Rx Mask is subject to being invalid data. The Rx Mask is the receiver property for each DQ input pin and it is not the valid data-eye.



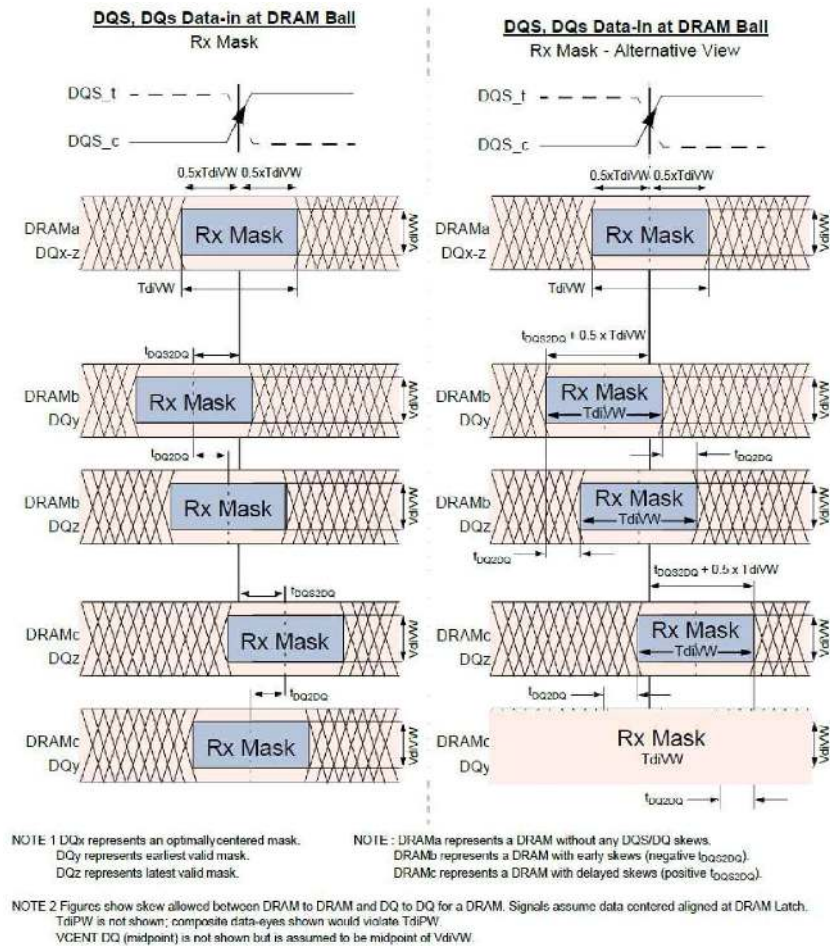
**DQ Receiver(Rx) compliance mask**



**$V_{cent\_DQ}$  Variation to  $V_{cent\_DQ}(midpoint)$**

The  $V_{ref\_DQ}$  voltage is an internal reference voltage level that shall be set to the properly trained setting, which is generally  $V_{cent\_DQ}(midpoint)$ , in order to have valid Rx Mask values.

$V_{cent\_DQ}(midpoint)$  is defined as the midpoint between the largest  $V_{ref\_DQ}$  voltage level and the smallest  $V_{ref\_DQ}$  voltage level across all DQ pins for a given DDR4 DRAM component. Each DQ pin  $V_{ref}$  level is defined by the center, i.e., widest opening, of the cumulative data input eye as depicted in  $V_{cent\_DQ}$  Variation to  $V_{cent\_DQ}(midpoint)$  figure. This clarifies that any DDR4 DRAM component level variation must be accounted for within the DDR4 DRAM Rx mask. The component level  $V_{ref}$  will be set by the system to account for  $R_{on}$  and ODT settings.



### DQS to DQ and DQ to DQ Timings at DRAM Balls

All of the timing terms in DQS to DQ and DQ to DQ Timings at DRAM Balls figure are measured at the VdiVW voltage levels centered around Vcent\_DQ( midpoint) and are referenced to the DQS\_t/DQS\_c center aligned to the DQ per pin.

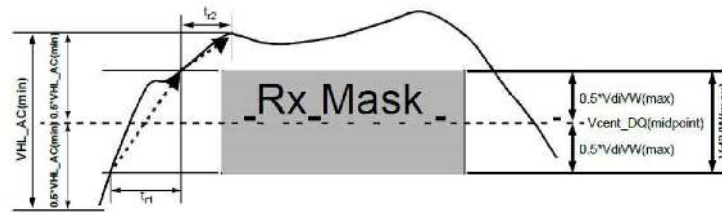


The rising edge slew rates are defined by srr1 and srr2. The slew rate measurement points for a rising edge are shown in Slew Rate Conditions For Rising Transition figure below: A low to high transition  $t_{r1}$  is measured from  $0.5 \cdot V_{dIVW}(\max)$  below  $V_{cent\_DQ}(\text{midpoint})$  to the last transition through  $0.5 \cdot V_{dIVW}(\max)$  above  $V_{cent\_DQ}(\text{midpoint})$  while  $t_{r2}$  is measured from the last transition through  $0.5 \cdot V_{dIVW}(\max)$  above  $V_{cent\_DQ}(\text{midpoint})$  to the first transition through the  $0.5 \cdot V_{IHL\_AC}(\min)$  above  $V_{cent\_DQ}(\text{midpoint})$ .

Rising edge slew rate equations:

$$srr1 = V_{dIVW}(\max) / t_{r1}$$

$$srr2 = (V_{IHL\_AC}(\min) - V_{dIVW}(\max)) / (2 \cdot t_{r2})$$

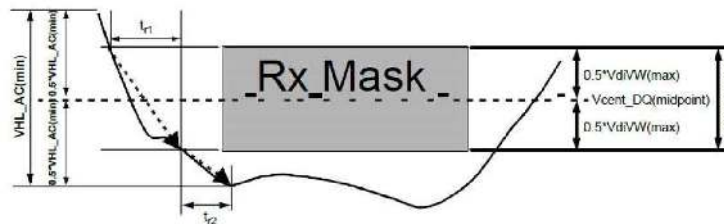


**Slew Rate Conditions For Rising Transition**

The falling edge slew rates are defined by srf1 and srf2. The slew rate measurement points for a falling edge are shown in Slew Rate Conditions For Falling Transition figure below: A high to low transition  $t_{f1}$  is measured from  $0.5 \cdot V_{dIVW}(\max)$  above  $V_{cent\_DQ}(\text{midpoint})$  to the last transition through  $0.5 \cdot V_{dIVW}(\max)$  below  $V_{cent\_DQ}(\text{midpoint})$  while  $t_{f2}$  is measured from the last transition through  $0.5 \cdot V_{dIVW}(\max)$  below  $V_{cent\_DQ}(\text{midpoint})$  to the first transition through the  $0.5 \cdot V_{IHL\_AC}(\min)$  below  $V_{cent\_DQ}(\text{pin mid})$ .

Falling edge slew rate equations:

$$srf1 = V_{dIVW}(\max) / t_{f1} \quad srf2 = (V_{IHL\_AC}(\min) - V_{dIVW}(\max)) / (2 \cdot t_{f2})$$



**Slew Rate Conditions For Falling Transition**



**DRAM DQs In Receive Mode; \* UI=tck(avg)min/2**

| Symbol     | Parameter                                              | DDR4-3200 |       | Unit | Note   |
|------------|--------------------------------------------------------|-----------|-------|------|--------|
|            |                                                        | min       | max   |      |        |
| VdIVW      | Rx Mask voltage - pk-pk                                | -         | 120   | mV   | 1,2,10 |
| TdIVW      | Rx timing window                                       | -         | 0.22  | UI*  | 1,2,10 |
| VIHL_AC    | DQ AC input swing pk-pk                                | 150       | -     | mV   | 6,10   |
| TdIPW      | DQ input pulse width                                   | 0.58      | -     | UI*  | 5,10   |
| tDQS2DQ    | Rx Mask DQS to DQ offset                               | -0.19     | 0.19  | UI*  | 6,10   |
| tDQ2DQ     | Rx Mask DQ to DQ offset                                | -         | 0.105 | UI*  | 7      |
| srr1, srf1 | Input Slew Rate over VdIVW if tCK >= 0.937ns           | 1.0       | 9     | V/ns | 8,10   |
|            | Input Slew Rate over VdIVW if 0.937ns > tCK >= 0.625ns | 1.25      | 9     | V/ns | 8,10   |
| srr2       | Rising Input Slew Rate over 1/2 VIHL_AC                | 0.2*srr1  | 9     | V/ns | 9,10   |
| srf2       | Falling Input Slew Rate over 1/2 VIHL_AC               | 0.2*srf1  | 9     | V/ns | 9,10   |

**Note:**

1. Data Rx mask voltage and timing total input valid window where VdIVW is centered around Vcent\_DQ( midpoint) after VrefDQ training is completed. The data Rx mask is applied per bit and should include voltage and temperature drift terms. The input buffer design specification is to achieve at least a BER = e-16 when the RxMask is not violated. The BER will be characterized and extrapolated if necessary using a dual dirac method from a higher BER(tbd).
2. Defined over the DQ internal Vref range 1.
3. Overshoot and Undershoot Specifications see AC overshoot/undershoot specification for Data, Strobe and Mask figure.
4. DQ input pulse signal swing into the receiver must meet or exceed VIHL AC(min). VIHL\_AC(min) is to be achieved on an UI basis when a rising and falling edge occur in the same UI, i.e., a valid TdiPW.
5. DQ minimum input pulse width defined at the Vcent\_DQ( midpoint).
6. DQS to DQ offset is skew between DQS and DQs within a nibble (x4) or word (x8, x16) at the DDR4 SDRAM balls over process, voltage, and temperature.
7. DQ to DQ offset is skew between DQs within a nibble (x4) or word (x8, x16) at the DDR4 SDRAM balls for a given component over process, voltage, and temperature.
8. Input slew rate over VdIVW Mask centered at Vcent\_DQ( midpoint). Slowest DQ slew rate to fastest DQ slew rate per transition edge must be within 1.7 V/ns of each other.
9. Input slew rate between VdIVW Mask edge and VIHL\_AC(min) points.
10. All Rx Mask specifications must be satisfied for each UI. For example, if the minimum input pulse width is violated when satisfying TdiVW(min), VdiVW(max), and minimum slew rate limits, then either TdiVW(min) or minimum slew rates would have to be increased to the point where the minimum input pulse width would no longer be violated.

## Command, Control, and Address Setup, Hold, and Derating

The total tIS (setup time) and tIH (hold time) required is calculated to account for slew rate variation by adding the data sheet tIS (base) values, the VIL(AC)/VIH(AC) points, and tIH (base) values, the VIL(DC)/VIH(DC) points; to the  $\Delta tIS$  and  $\Delta tIH$  derating values, respectively. The base values are derived with single-end signals at 1V/ns and differential clock at 2V/ns. Example: tIS (total setup time) = tIS (base) +  $\Delta tIS$ . For a valid transition, the input signal has to remain above/below VIH(AC)/VIL(AC) for the time defined by tVAC.

Although the total setup time for slow slew rates might be negative (for example, a valid input signal will not have reached VIH(AC)/ VIL(AC) at the time of the rising clock transition), a valid input signal is still required to complete the transition and to reach VIH(AC)/ VIL(AC). For slew rates that fall between the values listed in derating tables, the derating values may be obtained by linear interpolation.

Setup (tIS) nominal slew rate for a rising signal is defined as the slew rate between the last crossing of VIL(DC)max and the first crossing of VIH(AC)min that does not ring back below VIH(DC)min. Setup (tIS) nominal slew rate for a falling signal is defined as the slew rate between the last crossing of VIH(DC)min and the first crossing of VIL(AC)max that does not ring back above VIL(DC)max.

Hold (tIH) nominal slew rate for a rising signal is defined as the slew rate between the last crossing of VIL(DC)max and the first crossing of VIH(AC)min that does not ring back below VIH(DC)min. Hold (tIH) nominal slew rate for a falling signal is defined as the slew rate between the last crossing of VIH(DC)min and the first crossing of VIL(AC)min that does not ring back above VIL(DC)max.

### Command, Address, Control Setup and Hold Values

| DDR4             | 3200 | Unit | Reference |
|------------------|------|------|-----------|
| tIS(base, AC100) | -    | ps   | VIH/L(ac) |
| tIH(base, DC75)  | -    | ps   | VIH/L(dc) |
| tIS(base, AC90)  | 40   | ps   | VIH/L(ac) |
| tIH(base, DC65)  | 65   | ps   | VIH/L(dc) |
| tIS/tIH @ VREF   | 130  | ps   | VIH/L(dc) |

#### Note:

1. Base ac/dc referenced for 1V/ns slew rate and 2 V/ns clock slew rate.
2. Values listed are referenced only; applicable limits are defined elsewhere.

### Command, Address, Control Input Voltage Values

| DDR4          | 3200 | Unit | Reference |
|---------------|------|------|-----------|
| VIH.CA(AC)min | 90   | mV   | VIH/L(ac) |
| VIH.CA(DC)min | 65   | mV   | VIH/L(dc) |
| VIL.CA(DC)max | -65  | mV   | VIH/L(ac) |
| VIL.CA(AC)max | -90  | mV   | VIH/L(dc) |

#### Note:

1. Command, Address, Control input levels relative to VREFCA.
2. Values listed are referenced only; applicable limits are defined elsewhere.

**Derating values DDR4-3200 tIS/tIH - ac/dc based**

| $\Delta tIS, \Delta tIH$ derating in [ps] AC/DC based <sup>1</sup>                |            |                                   |              |              |              |              |              |              |              |              |              |              |              |              |              |              |              |
|-----------------------------------------------------------------------------------|------------|-----------------------------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|
|                                                                                   |            | CK_t, CK_c Differential Slew Rate |              |              |              |              |              |              |              |              |              |              |              |              |              |              |              |
|                                                                                   |            | 10.0V/ns                          |              | 8.0V/ns      |              | 6.0V/ns      |              | 4.0V/ns      |              | 3.0V/ns      |              | 2.0V/ns      |              | 1.5V/ns      |              | 1.0V/ns      |              |
|                                                                                   |            | $\Delta tIS$                      | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ | $\Delta tIS$ | $\Delta tIH$ |
| <b>CMD,<br/>ADDR,<br/>CNTL<br/>Input<br/>Slew<br/>rate<br/>V/ns</b>               | <b>7.0</b> | 68                                | 47           | 69           | 47           | 70           | 48           | 72           | 50           | 73           | 52           | 77           | 56           | 85           | 63           | 100          | 78           |
|                                                                                   | <b>6.0</b> | 66                                | 45           | 67           | 46           | 68           | 47           | 69           | 49           | 71           | 50           | 75           | 54           | 83           | 62           | 98           | 77           |
|                                                                                   | <b>5.0</b> | 63                                | 43           | 64           | 44           | 65           | 45           | 66           | 46           | 68           | 48           | 72           | 52           | 80           | 60           | 95           | 75           |
|                                                                                   | <b>4.0</b> | 59                                | 40           | 59           | 40           | 60           | 41           | 62           | 43           | 64           | 45           | 68           | 49           | 75           | 56           | 90           | 71           |
|                                                                                   | <b>3.0</b> | 51                                | 34           | 52           | 35           | 53           | 36           | 54           | 38           | 56           | 40           | 60           | 43           | 68           | 51           | 83           | 66           |
|                                                                                   | <b>2.0</b> | 36                                | 24           | 37           | 24           | 38           | 25           | 39           | 27           | 41           | 29           | 45           | 33           | 53           | 40           | 68           | 55           |
|                                                                                   | <b>1.5</b> | 21                                | 13           | 22           | 13           | 23           | 14           | 24           | 16           | 26           | 18           | 30           | 22           | 38           | 29           | 53           | 44           |
|                                                                                   | <b>1.0</b> | -9                                | -9           | -8           | -8           | -8           | -8           | -6           | -6           | -4           | -4           | 0            | 0            | 8            | 8            | 23           | 23           |
|                                                                                   | <b>0.9</b> | -15                               | -13          | -15          | -12          | -14          | -11          | -12          | -9           | -10          | -7           | -6           | -4           | 1            | 4            | 16           | 19           |
|                                                                                   | <b>0.8</b> | -23                               | -17          | -23          | -17          | -22          | -16          | -20          | -14          | -18          | -12          | -14          | -8           | -7           | -1           | 8            | 14           |
|                                                                                   | <b>0.7</b> | -34                               | -23          | -33          | -22          | -32          | -21          | -30          | -20          | -28          | -18          | -25          | -14          | -17          | -6           | -2           | 9            |
|                                                                                   | <b>0.6</b> | -47                               | -31          | -47          | -30          | -46          | -29          | -44          | -27          | -42          | -25          | -38          | -22          | -31          | -14          | -16          | 1            |
|                                                                                   | <b>0.5</b> | -67                               | -42          | -66          | -41          | -65          | -40          | -63          | -38          | -61          | -36          | -58          | -33          | -50          | -25          | -35          | -10          |
|                                                                                   | <b>0.4</b> | -95                               | -58          | -95          | -57          | -94          | -56          | -92          | -54          | -90          | -53          | -86          | -49          | -79          | -41          | -64          | -26          |
| <b>Note: 1. VIH/L(ac) = +/-tbd mV, VIH/L(dc) = +/- tbd mV; relative to VREFCA</b> |            |                                   |              |              |              |              |              |              |              |              |              |              |              |              |              |              |              |

## DDR4 Function Matrix

DDR4 SDRAM has several features supported by ORG and also by Speed. The following Table is the summary of the features.

**Function Matrix (By ORG. V:Supported, Blank: Not supported)**

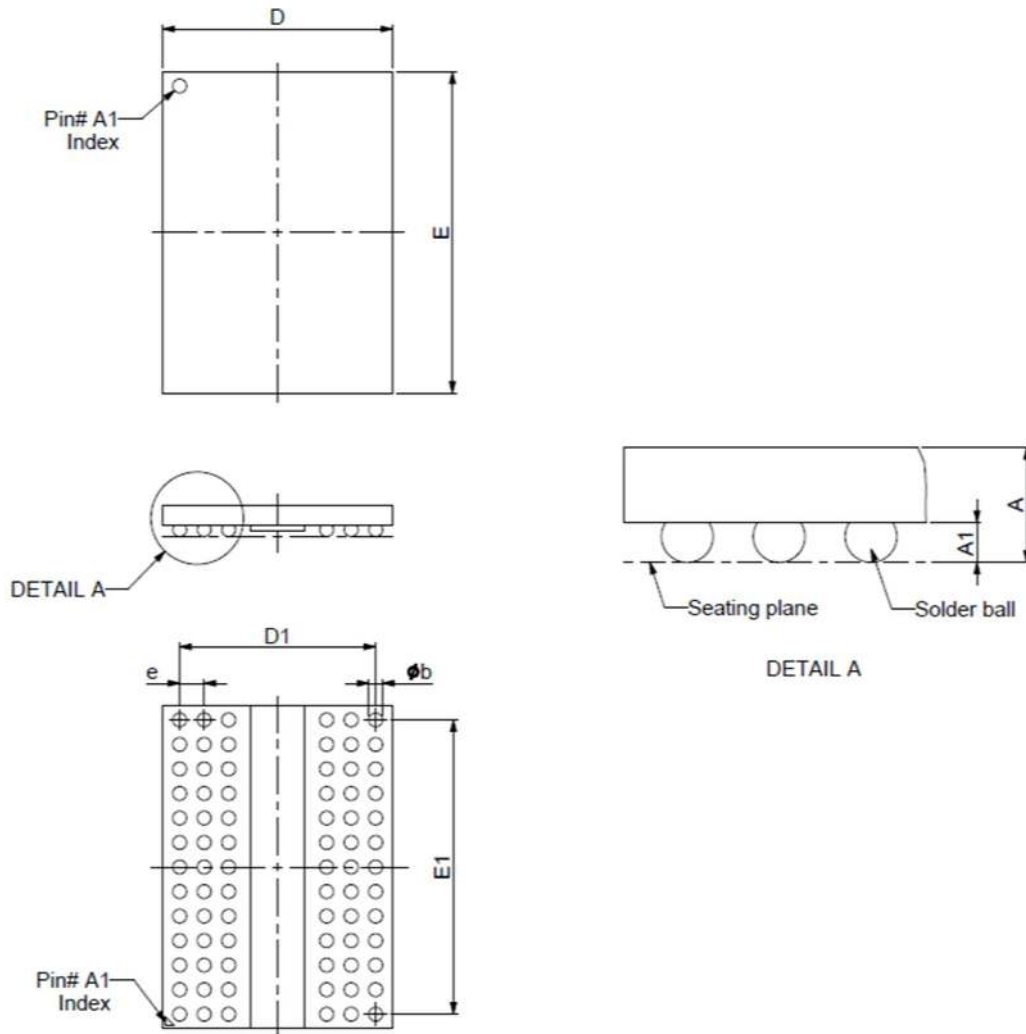
| Functions                      | X8 | Note |
|--------------------------------|----|------|
| Write Leveling                 | V  |      |
| Temperature controlled Refresh | V  |      |
| Low Power Auto Self Refresh    | V  |      |
| Fine Granularity Refresh       | V  |      |
| Multi Purpose Register         | V  |      |
| Data Mask                      | V  |      |
| Data Bus Inversion             | V  |      |
| TDQS                           | V  |      |
| ZQ calibration —               | V  |      |
| DQ Vref Training               | V  |      |
| Per DRAM Addressability        | V  |      |
| Mode Register Readout          | V  |      |
| CAL                            | V  |      |
| WRITE CRC                      | V  |      |
| CA Parity                      | V  |      |
| Control Gear Down Mode         | V  |      |
| Programmable Preamble          | V  |      |
| Maximum Power Down Mode        | V  |      |
| Boundary Scan Mode             |    |      |
| Additive Latency               | V  |      |

**Function Matrix (By Speed. V:Supported, Blank: Not supported)**

| Functions                       | DLL Off mode                 | DLL On mode | Note |
|---------------------------------|------------------------------|-------------|------|
|                                 | equal or slower than 250Mbps | 3200Mbps    |      |
| Write Leveling                  | V                            | V           |      |
| Temperature controlled Refresh  | V                            | V           |      |
| Low Power Auto Self Refresh     | V                            | V           |      |
| Fine Granularity Refresh        | V                            | V           |      |
| Multi Purpose Register          | V                            | V           |      |
| Data Mask                       | V                            | V           |      |
| Data Bus Inversion              | V                            | V           |      |
| TDQS                            |                              | V           |      |
| ZQ calibration                  | V                            | V           |      |
| DQ Vref Training                | V                            | V           |      |
| Per DRAM Addressability         |                              | V           |      |
| Mode Register Readout           | V                            | V           |      |
| CAL                             |                              | V           |      |
| WRITE CRC                       |                              | V           |      |
| CA Parity                       |                              | V           |      |
| Control Gear Down Mode          |                              |             |      |
| Programmable Preamble ( = 2tCK) |                              |             |      |
| Maximum Power Down Mode         |                              | V           |      |
| Boundary Scan Mode              | V                            | V           |      |

## PACKAGING DIMENSIONS

78-BALL (7.5x11.0 mm)



| Symbol               | Dimension in mm |       |       | Dimension in inch |       |       |
|----------------------|-----------------|-------|-------|-------------------|-------|-------|
|                      | Min             | Norm  | Max   | Min               | Norm  | Max   |
| <b>A</b>             | ---             | ---   | 1.20  | ---               | ---   | 0.047 |
| <b>A<sub>1</sub></b> | 0.32            | 0.37  | 0.42  | 0.013             | 0.015 | 0.017 |
| <b>Φ<sub>b</sub></b> | 0.45            | 0.50  | 0.55  | 0.018             | 0.020 | 0.022 |
| <b>D</b>             | 7.40            | 7.50  | 7.60  | 0.291             | 0.295 | 0.299 |
| <b>E</b>             | 10.90           | 11.00 | 11.10 | 0.409             | 0.413 | 0.417 |
| <b>D<sub>1</sub></b> | 6.40 BSC        |       |       | 0.252 BSC         |       |       |
| <b>E<sub>1</sub></b> | 9.60 BSC        |       |       | 0.378 BSC         |       |       |
| <b>e</b>             | 0.80 BSC        |       |       | 0.031 BSC         |       |       |

Controlling dimension : Millimeter

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